

# MASTR Executive II MAINTENANCE MANUAL

BASE STATION DC REMOTE CONTROL 19D424457G1-G9

### SPECIFICATIONS \*

LINE TERMINATING IMPEDANCE

LINE LOOP IMPEDANCE

AUDIO LINE OUTPUT

FREQUENCY RESPONSE

DISTORTION

TEMPERATURE RANGE

600 ohms

11,000 ohms (8000 Line and

3000 Matching) Maximum

-20 dBm to +11 dBm

 $\pm 3$  dB from 300 to 3000 Hz

Less than 3%

-30°C to +60°C  $(-22^{\circ}F \text{ to } +140^{\circ}F)$ 

\*These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

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-- WARNING ----

No one should be permitted to handle any portion of the equipment that is supplied with high voltage; or to connect any external apparatus to the units while the units are supplied with power. KEEP AWAY FROM LIVE CIRCUITS.

#### **DESCRIPTION**

The General Electric MASTR® Executive II Desk Top and Wall Mount stations use DC Remote Control boards to interface with a remote control console in remote and local/remote station combinations. The boards provide up to five remotely controlled functions by the application of different current levels and polarities to select each function. The Desk Top Local/Remote station utilizes the 19D424457G1 or 19D424457G5 DC Remote Control Board for remote transmit and Channel Guard monitor functions. DC Remote Control Boards 19D424457G1-G5 may all be used with the Wall Mount Remote Control Station. DC Remote Control boards 19D424457G8 & G9 are used in GE-MARC V Applications.

Three negative current levels and two positive current levels may be applied to the telephone line at the remote control console:  $\pm 6$  mA;  $\pm 11$  mA; -2.5 mA.

#### DC CONTROL FUNCTIONS

These control currents are provided by the General Electric MASTR Controller and Deskon II. For functions provided by the TCC or Deskon units (6 mA for Channel Guard Monitor and 15 mA for transmit control) Option 9924 should be used. This option deletes the 19D424457G5 board and substitutes the 19D424457G3 board with modifications. Refer to the Schematic Diagram for modification instructions.

#### TELEPHONE LINE CHARACTERISTICS

The key link in a remot control installation is the telephone pair between the Controller and the base station. To obtain the most satisfactory service over this

link, some general knowledge of the capabilities of such lines is required.

A telephone pair is simply a pair of wires, normally ranging from AWG #19 to AWG #26 in size. These wires, furnished by the local telephone company, pass through overhead cables, underground cables, through junction points, and switchboards. To the user, however, they may be considered a simple pair of wires. Equipment that is designed to operate with such a pair should have nominal impedance of 600 ohms. A telephone pair will normally have a maximum length of about 12 miles before amplification is added by the telephone company to make up for line losses. There is an inherent loss in any telephone line installation due to the series inductance and resistance and the shunt capacitance of the wires.

This loss is a direct function of the length of the line, and varies with the wire size used. As an example, with AWG #19 wire, a distance of six miles may be covered before one-half the input voltage of a 1000 Hz tone is lost. With AWG #26 wire, only two and one-quarter miles may be covered before one-half the input voltage is lost. Line losses as high as 30 dB can be tolerated in operating a transmitter from the Remote but such high losses should be avoided whenever possible. Although the telephone pair is fairly well balanced, some noise will be induced into the line, especially if an unshielded run has to be made in a flourescentlighted building.

The DC resistance of any telephone pair will affect the control circuits between the Controller and the base station. Current regulators incorporated in the Remote Control minimize these variations after initial adjustment. The Remote operates with a total control line loop resistance as great as 11,000 ohms. There is a possibility, however, that stray currents, due to leakage, noise, faults, earth currents, etc., may cause faulty operation.

		CON	TROL CURRE	ENT IN MILI	JIAMPERES		,
DC CONTROL BOARD	FUNCTION	-11	-6	-2.5	0	+6	+11
19D424457G1	1 Freq. Transmit 1 Freq. Receive		4.		Receive	Transmit	
19D424457G2	1 or 2 Freq. Transmit 2 Freq. Receive		Receive F2		Receive F1	Transmit Fl	Transmit F2
19D424457G3	1 or 2 Freq. Transmit 1 Freq. Receive/CG Monitor			CG Disable	Receive with CG	Transmit Fl	Transmit F2
19D424457G4	1 or 2 Freq. Transmit 2 Freq. Receive/CG Monitor	Receive F2 CG Disable	Receive F2 with CG	Receive F1 CG Disable	Receive Fl with CG	Transmit Fl	Transmit F2
19D424457G5	1 Freq. Transmit 1 Freq. Receive/CG Monitor			Receive CG Disable	Receive with CG	Transmit	
19D424457G8,9				Clear	Receive	Transmit	

Three types of telephone line connections are commonly used. Before choosing one of these types, consider the cost and performance of each, as one type may be available at a much lower rate. Also, some telephone companies offer no choice. The following chart contains information to assist in selecting the control method and type of telephone line to be used in DC control applications. Refer to Figure 1.

METHOD	DESCRIPTION	ADVANTAGES OR DISADVANTAGES
1	One metallic pair: for both audio and control voltages with control voltage from line to line.	Economical; dependable where earth currents may be large; slight keying clicks will be heard in paralleled Remote Control Units. In most applications, preferred over Method No. 2.
2	One metallic pair: for both audio and control voltages with control voltages from line to ground.	Economical; earth ground currents may result in interference with control functions; keying click minimized. Good earth to ground required at station and all control points.
3	Two telephone pairs; one for audio voltage and one for control voltage (metallic pair).	Provides best performance; keying clicks will not be heard. Requires 2 pair.

#### TELEPHONE LINE CONNECTIONS

The station is normally shipped with jumpers connected on the Remote Control Board as described in Method 1. If Method 2 or 3 is to be used, connect the jumpers as shown in the following chart.

CONTROL METHOD	TELEPHONE LINE CONNECTIONS	JUMPER CONNECTIONS
1	Connect telephone lines to TB1-1 and -2.	Jumper H32 to H33 and H34 to H35.
2	Connect telephone lines to TB1-1 and -2. Connect good earth ground to TB1-4.	Move jumper from H34- H35 to H33-H35.
3	Connect audio telephone lines to TB1-1 and -2 and control lines to TB1-3 and -4.	Remove jumpers from H32 to H33 and H34 to H35.

### Proper Grounding Practices (Method 2)

The telephone company specifies that their customer's equipment signal ground should be made using the proper connection to a ground electrode such as a metallic cold water pipe. The ground connection should be made with a single No. 14 AWG or larger copper conductor. The conductor should be short, straight and a continuous piece of wire. Attention should be given to providing the lowest possible resistance at the connection at each end of the ground wire.

When option line surge protection devices are provided in the customer equipment, it is imperative that the good earth ground be used. If the telephone company also provides protective devices, the customer provided device earth ground connections should be located close to the telephone company earth ground connections but should not use the same ground clamp that

the telephone company uses.

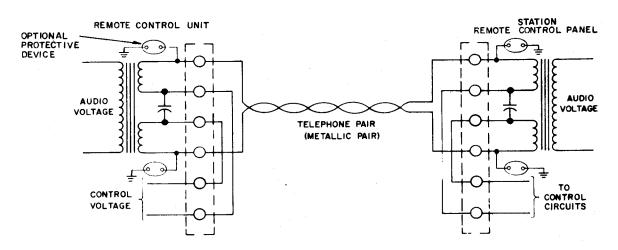
If a good earth ground as described above cannot be obtained, Method 2 should not be used. Also, the addition of surge protective devices are of little value without the proper earth ground.

#### REMOTE CONTROL ADJUSTMENTS

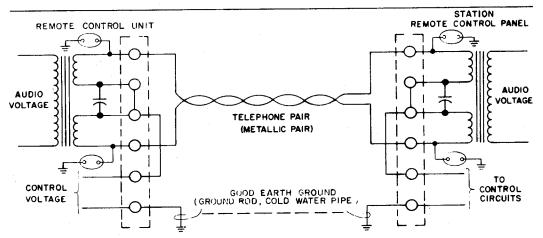
When the station is equipped with a DC Remote Control board, REMOTE TX MOD LEVEL and REC LINE LEVEL controls must be adjusted before placing the station in operation.

#### A. REMOTE TX MOD LEVEL

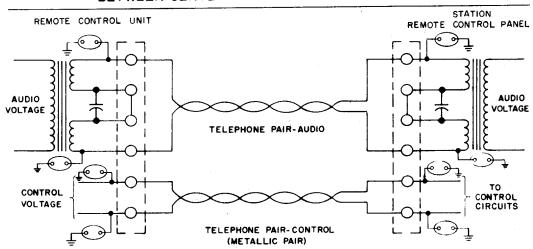
1. Feed a 1000 Hertz tone at the required level into a microphone jack on the remote control console. Adjust the remote control console line output control for 2.7 Volts



METHOD I - SINGLE TELEPHONE PAIR WITH CONTROL LINE TO LINE



METHOD 2- SINGLE TELEPHONE PAIR WITH CONTROL BETWEEN CENTER TAP AND GROUND



METHOD 3- SEPARATE CONTROL AND AUDIO PAIRS

RC-2556B

Figure 1 - Telephone Line Connections

RMS as measured across the audio pair at the remote control console.

 Key the station transmitter from the remote control console and adjust the REMOTE TX MOD LEVEL Control R27 on the DC Remote Control Board for 4.5 kHz system deviation as measured at the station transmitter.

#### B. REC LINE LEVEL

- 1. Connect a signal generator to the station receiver. Adjust the generator to the receiver frequency, modulated at 3 kHz deviation by a 1000 Hertz tone. Disable Channel Guard if present.
- 2. Adjust the REC LINE LEVEL control R16 on the DC Remote Control Board for a reading of 2.7 Volts RMS as measured at the station audio pairs (TB1-1 and -2 when using separate control and audio pairs; TB1-3 and -4 when using common control and audio pairs).

### CIRCUIT ANALYSIS

#### Remote Control Board 19D424457G1

Remote Control Board 19D424457Gl provides single frequency transmit and single frequency receive DC control functions. The board consists of an optocoupler (U5) used for current control and line isolation. The coupler contains a Light Emitting Diode (LED) serving as a light source and a light-sensitive phototransistor serving as a light detector. The light source and detector are both housed in a single package, sealed from outside light. When a DC current of the correct polarity to forward bias the LED is applied to the input of the optocoupler, the LED conducts and emits light. This light is detected by the phototransistor, turning it on and coupling the input signal to the output of the optocoupler.

When zero current is present on the control pair (TB1-3 and -4), the LED in U5 is turned off. The phototransistor in U5 is therefore not conducting, holding Q4 off. This is the receive mode of the control circuit. Applying +6 mA to the control pair will result in the voltage at the base of Q1 being clamped to 6 VDC. The voltage at the emitter of Q1 rises to 0.6 VDC above the base and the transistor is turned off, allowing the LED in U5 to conduct. The phototransistor detects the light and operates. The high at the emitter of the phototransistor turns on Q4. Conduction of Q4 turns on emitter-follower Q5 which, in turn, operates Q6. Conduction of Q6 applies ground to the REMOTE PTT terminal P901-4 to key the station transmitter.

Audio circuits provided on the 19D424457G1 Remote Control Board include a high-pass filter, audio-amplifier, a deemphasis network and a line driver for feeding the receive audio to the telephone lines. A modulation amplifier and level control are provided for controlling the line audio fed to the transmitter modulator. Audio and RUS switches are included for switching the transmit and receive audio paths.

Audio from the station receiver discriminator is coupled to audio amplifier AR1 and de-emphasis network C10 and R13. The de-emphasis network provides a 6 dB/octave rolloff. The signal is then amplified by Q15. The REC LINE LEVEL control R16 is connected in the emitter circuit of Q15 and allows feeding the audio to the line amplifier at the proper level.

The audio is coupled to the line amplifier by means of C12. Q19 and Q20 amplify the signal. Q17 and Q18 serve as audio switches controlled by the Receiver Unsquelched Sensor (RUS) circuit. As long as the RUS switch (Q14) is turned off (receiver squelched), CR21 and CR20 are forward biased, allowing Q17 and Q18 to conduct. Conduction of Q17 and Q18 grounds the audio path, preventing the received audio from passing to the line. When the receiver unsquelches, the RUS lead goes high. This turns Q14 on, turning off Q17 and Q18. The audio is now allowed to pass to the line amplifier and line transformer T1. VR7 and VR4 are provided for line surge protection.

Audio from the Remote Control unit applied to the telephone pair is coupled to the input of the transmitter audio amplifier (Q21 and Q26). The proper audio level for the transmitter modulator is adjusted by REMOTE TX MOD LEVEL control R27.

Transistor Q26 is controlled by the transmit PTT circuit. If Q5 is conducting (the control circuit in the transmit mode), the base of Q26 is high, allowing the transmit audio to pass to P901-1 (TX AUDIO H1). When Q5 is turned off (receive mode), Q26 is held off and prevents the transmit audio from passing to the transmitter modulator.

#### Remote Control Board 19D424457G2

Remote Control Board 19D424457G2 is used for 1- or 2- frequency transmit and 2-frequency receive. Three optocouplers are utilized on this board to derive the control functions. If zero current is present on the control pair, all of the LED's in the optocouplers (U3, U4, U5) are turned off. Thus all three of the phototransistors are turned off.

The NAND gates (UIA, UIB, etc.) require two low inputs to provide a high output. All other conditions provide a low output. The high at the collector of the U3 phototransistor is connected to NAND date U2A.

pin 1. The high at the collector of the U5 phototransistor is connected to U2A-2. The resultant low at U2A-3 holds Q10 and Q16 off. The high at the collector of Q10 prevents selection of the RECEIVE F2 oscillator. The high at the collector of Q16 operates Q9, applying ground to select the RECEIVE F1 oscillator.

In this board a diode bridge is connected across the control pair, providing line transient protection. One leg of the bridge contains the polarity detector optocoupler U4. With no current applied to the line, the phototransistor in U4 is turned off. The high at its collector is connected to U2C-9. U2C-8 is low. The resultant low at U2C-10 holds Q7 off, preventing selection of the TRANSMIT F1 oscillator.

The POSITIVE DETECT lead from U4 is also connected to pin 6 of U1B. The high from the collector of the U5 phototransistor is connected to U1A-1. The high from U3 is connected to U1C-9. The low at U1C-10 is connected to U1A-2. The low at U1A-3 is connected to U1D-12. The low at U1B-4 is connected to U1D-13. The resultant high is connected to U1B-5. The low output of U1B holds Q13 off, preventing selection of the TRANSMIT F2 oscillator. Q29 is turned on under these conditions, preventing Q4 and Q5 from conducting. This holds Q6 off, preventing transmitter keying.

When a DC control current is first applied to the control pair, the diode bridge directs the current to the current detectors. Optocoupler U4 operates if the line current is positive. When the positive current is first applied to the line, CR9 is reverse biased, keeping Q3 turned off. The LED in U3 is turned on, operating the phototransistor. CR8 is forward biased, turning Q1 on. Optocoupler U5 is thus shorted out. As more line current is applied, the voltage at the base of Q1 will rise and be clamped at 5.4 VDC. When the voltage at the emitter of Q1 rises to within 0.6 VDC of the base, the transistor will turn off and let current flow through the LED in U5, turning on the phototransistor.

Applying +6 mA (TRANSMIT F1) to the control pair results in the conditions just described. The low from the collector of the phototransistor in U5 is applied to U2A-2. The low from the collector of the U3 phototransistor is applied to U2A-1. The resultant high at U2A-3 operates Q16. The low at the collector of Q16 holds Q9 off, preventing selection of the RECEIVE F1 oscillator. The low at the collector of U4 is connected to U1B-6. The low from U5 is connected to U1A-1. U1A-2 is high. The resultant low at U1A-3 is connected to U1D-12. U1D-13, connected to the output of U1B-4, is low. The high at U1D-11 is connected to U1B-5. The low at U1B-4 holds Q13 off, preventing selection of the TRANS-MIT F2 oscillator.

The low from the collector of the POSITIVE DETECT phototransistor (U4) is connected to U2C-9. The low at the output of U1B-4 is connected to U2C-8. The resultant high at U2C-10 operates Q7, selecting the TRANSMIT F1 oscillator. Q29 is turned off, turning on Q4 and Q5. Conduction of Q5 operates Q6, keying the station transmitter.

When +11 mA (TRANSMIT F2) is applied to the control pair, the voltage on the emitter of Q3 will be higher than the 10.7 volts present on the base. Q3 will thus conduct. Below 11 mA, the voltage at the cathrode of VR3 will be higher than the emitter of Q3, preventing the transistor from conducting. When Q3 conducts, the LED in U3 is shorted out. U4 and U5 are operating.

A high is connected to U2A-1 from U3. A low is connected to U2A-2 from U5. resulting low holds Q10 and Q16 off, preventing selection of the RECEIVE F2 oscil-The high from U3 is also applied The low at U1C-10 is connected to UlC-9. to UlA-2. The low from U5 is connected to UlA-1. The resulting high at UlA-3 is connected to U1D-12. The low at U1D-11 connects to U1B-5. U1B-6 is low. U1B-4 is thus high, operating Q13 and selecting the TRANSMIT F2 oscillator. U2C-9 is low; U2C-8 is high. This results in a low at U2C-10, preventing Q7 from conducting and selecting the TRANSMIT F1 oscillator. Q29 is turned off, operating Q4, Q5 and Q6 to key the transmitter.

The audio amplifier circuits on this board operate in the same manner as described for the 19D424457Gl board. When PTT is selected, conduction of Q5 operates Q27. Conduction of Q27 operates Q28, applying +10 VDC to the base of Q26 to allow the transmit audio to pass to P901-1 (TX AUDIO H1).

## DC Remote Control Boards 19D424457G3-G5, G8 and G9

DC Remote Control Board 19D424457G3 provides up to two-frequency transmit and single-frequency receive with Channel Guard Monitor. The 19D424457G4 Board provides up to two-frequency transmit and two-frequency receive with Channel Guard Monitor. The 19D424457G5 Board provides single-frequency transmit and receive with Channel Guard Monitor. The 19D424457G8, G9 Boards provide single-frequency transmit and receive with the "CLEAR" function.

#### Channel-Guard Monitor

The 19D424457G3-G5, G8, G9 boards function in the same manner as described for the G1 & G2 boards when selecting the transmit and receive oscillators. When the Channel Guard disable/"CLEAR" control current of -2.5 mA is applied to the control pair, Q1 is allowed to conduct but Q2 is turned off.

Thus optocoupler U3 is operated and optocouplers U4 & U5 are turned off. The high at the collector of the U5 phototransistor is connected to U2A-2 and U2D-12. Pin 13 of U2D is low. The low at U2D-11 is applied to U2B-5. The low at the collector of the U3 phototransistor is connected to U2B-6. The resultant high at U2B-4 operates Q12, applying ground to the CG MONITOR lead P901-11. With Channel Guard disabled, the station receiver now operates only on noise squelch so that all transmissions on the receiver frequency will be heard.

#### Two-Frequency Receive

The 19D424457G4 Board permits two-frequency receive selection with Channel Guard Monitor. With -2.5 mA applied to the control pair, the low from the collector of the U3 phototransistor is connected to U2A-1, U1C-9 and U2B-6. The high from the collector of the U5 phototransistor is connected to U2A-2, U1A-1 and U2D-12. The low output of U2A holds Q10 and Q16 off. The low output of U1A keeps Q8 and Q11 from conducting. The high at the collector of Q16 operates Q9, selecting the RECEIVE F1 oscillator. The high at U2B-4 operates Q12, disabling Channel Guard.

When -6 mA (RECEIVE F2) is applied to the control pair, U3 and U5 are operated but U4 is turned off. This results in conduction of Q16, holding Q9 off and preventing selection of the RECEIVE F1 oscillator. The high at U2A-3 operates Q10, selecting the RECEIVE F2 oscillator. The output of U2B (pin 4) is low, preventing Q12 from operating. Thus Channel Guard is functioning.

When -11 mA (RECEIVE F2, CG MONITOR) is applied to the control pair, Q1 and Q2 are turned off and Q3 is turned on. Thus U5 is operating and U3 and U4 are turned off. The low at the collector of the phototransistor in U5 is applied to U2A-2, U1A-1 and U2D-12. The high at the collector of the phototransistor in U3 is connected to U2A-1, U1C-9 and U2B-6. The low at U2A-3 holds Q10 and Q16 off. The high at U1A-3 operates Q8 and Q11. Conduction of Q8 prevents Q9 from conducting and thus prevents selection of RECEIVE F1. Conduction of Q11 selects RECEIVE F2.

The output of U2B is low, reverse biasing CR16. The high at U1A-3 forward biases CR15, operating Q12 and disabling Channel Guard.

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# DC REMOTE CONTROL BOARD 19D424457G1 DC VOLTAGE READINGS

# DC REMOTE CONTROL BOARD 19D424457G2 DC VOLTAGE READINGS

All readings are typical readings made with a 20,000 ohms-per-Volt meter. All readings are typical readings made with a 20,000 ohms-per-Volt meter.

ETERING POINT	REFERENCE		CONTROL CURRENT (MA)			
		0	+6			
AR1-2	Ground	4.42V	4.42			
-3		4.42V	4.42			
-6		4.42V	4.42			
Q4-E		.04V	8.70V			
B		OV	9.20V			
C		9.4V	9.40V			
Q5-E		OV	8.0V			
B		.04V	8.7V			
C		9.4V	9.4V			
Q6-E		0V	.96V			
B		0V	1.51V			
C		10.0V	.08V			
Q14→E		OV	OV			
B		.63V	.64V			
C		.04V	.05V			
Q15-E		3.85V	3.85V			
B		4.45V	4.48V			
C		9.0V	9.0V			
Q17-E		0V	0V			
B		.08V	•13V			
C		.02V	•03V			
Q18-E		OV	OV			
B		.16V	.17V			
C		4.45V	4.45V			
Q19-E		1.51V	1.51V			
B		2.09V	2.09V			
C		9.0V	9.0V			
Q20-E		.96V	.96V			
B		1.52V	1.52V			
C		7.60V	7.60V			
Q21-E		.91V	.92V			
B		1.49V	1.50V			
C		4.50V	4.75V			
Q26-E		OV	4.8V			
B		OV	5.4V			
C		4.50	4.75V			
U5-4		OV	9.3V			
5		9.4V	9.4V			
Q1-E B C	Pin 4 (Control -)	OV OV OV	7.7V 5.6V 8.8V			
U5-1		OV	8.8V			
2		OV	7.7V			

ETERING POINT	REFERENCE	CONTROL CURRENT (MA)					
		-6	0	+6	+11		
AR1-2 3 6	Ground		4.85V 4.82V 4.82V				
Q4-E B C		.04V OV 10.0V	.03V OV 10.0V	3.45V 4.0V 10.0V	5.4V 6.0V 10.0V		
Q5-E B C		0V .04V 10.0V	0V 0V 10.0V	2.8V 3.45V 10.0V	4.8V 5.4V 10.0V		
Q6-E B C		0V 0V 10.0V	0V 0V 10.0V	OV .73V .14V	0V .74V .10V		
Q7-E B C		OV OV 8.5V	OV OV 8.5V	0V .69V .10V	OV .14V 8.5V		
Q9-E B C		0V 0V 8.7V	OV .65V .10V	OV OV 8.7V	0V .69V .12V		
Q10-E B C		0V .68V .08V	0V 0V 8.40V	0V .69V .10V	OV OV 8.5V		
Q13-E B C		0V 0V 8.5V	0V 0V 8.40V	OV OV 8.5V	0V .68V .10V		
Q14-E B C			0V .64V .04V				
Q15-E B C			4.10V 4.70V 9.65V				
Q16-E B C		OV .62V .02V	OV OV 6.5V	0V .62V .02V	0V 0V 6.45V		
Q17-E B C			0V .13V .03V				
Q18-E B C			0V .18V 4.70V				
Q19-E B C			1.55V 2.10V 9.65V				
Q20-E B C			.95V 1.55V 8.3V				
Q21-E B C			1.05V 1.60V 4.70V				

METERING POINT	REFERENCE	CONTROL CURRENT (MA)				
		-6	0	+6	+11	
Q26-E	Ground	5.4V	OV	5.4V	5.4V	
B		6.0V	OV	6.0V	6.0V	
C		5.4V	4.7V	5.4V	5.4V	
Q27-E		OV	OV	0V	0V	
B		•12V	.12V	.14V	.16V	
C		•85V	.76V	.80V	.84V	
Q28-E		10.0V	10.0V	10.0V	10.0V	
B		9.3V	9.2V	9.3V	9.3V	
C		10.0V	9.95V	10.0V	10.0V	
U5 <b>-4</b>		OV	OV	ov	ov	
5		•12V	10.0V	.13v	ov	
U3-4		OV	OV	OV	0V	
5		•12V	10.0V	.14V	9.9V	
U4-4		0V	OV	OV	OV	
5		10.0V	10.0V	.13V	OV	
U1-1 2 3 4 5 6 8 9 10 11 12 13		0V 10.0V 0V 10.0V 9.7V 0V 0V 10.0V 10.0V 0V	9.8V OV OV OV 10.0V 9.7V OV 9.7V OV 10.0V OV	10.0V 0V 0V 10.0V 0V 0V 0V 10.0V 10.0V 0V	OV OV 10.0V 10.0V OV OV 10.0V OV OV 10.0V OV	
U2-1 2 3 4 5 6 8 9 10 11 12 13		0V 0V 9.6V 0V 10.0V 0V 9.7V 0V 10.0V 0V	9.7V 9.7V OV OV OV 9.7V 6.4V 9.7V OV OV 9.7V	0V 0V 9.5V 0V 10.0V 0V 0V 0V 10.0V 0V 0V 0V 0V	9.8V OV OV 10.0V 9.8V 6.4V OV OV 10.0V OV .5V	
Q1-E B C	Pin 4 (Control -)	-9.8V -9.2V -8.7V	OV OV OV	7.5V 6.2V 8.6V	11.0V 6.5V 12.0V	
Q3-E		-7.7V	OV	9.6V	12.2V	
B		-6.5V	OV	9.0V	11.3V	
C		-8.7V	OV	8.6V	12.2V	
U5-1		-8.8V	ov	8.6V	12.2V	
2		-9.8V	ov	7.5V	11.0V	
U3-1		-7.7V	OV	9.6V	12.2V	
2		-8.7V	OV	8.6V	12.10V	
U4-1		-17V	OV	18.4V	26.8V	
2		-5.V	OV	17.3V	25.7V	

# DC REMOTE CONTROL BOARD 19D424457G3 DC VOLTAGE READINGS

All readings are typical readings made with a 20,000 ohms-per-Volt meter.

METERING POINT	REFERENCE	CONTROL CURRENT (MA)			
		-2.5	0	+6	+11
AR1-2 3 6	Ground		4.9V 4.9V 4.9V		
Q4-E B C		0V 0V 10.0V	OV OV 10.0V	3.42V 3.98V 10.0V	5.6V 6.2V 10.0V
Q5 <b>-</b> E B C		0V 0V 10.0V	OV OV 10.0V	2.75V 3.42V 10.0V	4.9V 5.6V 10.0V
Q6-E B C		0V 0V 10.0V	OV OV 10.0V	0V •70V •02V	0V .74 .09
Q7 <b>-</b> E B C		0V 0V 8.6V	OV OV 8.6V	0V .69V .09V	0V .47 8.6V
Q9 <b>-</b> E B C		OV .66V .10V	OV .65V .10V	OV OV 8.7V	0V .67
Q12-E B C		OV .68V .10V	OV OV 8.5V	OV OV 8.5V	0V .32 8.6V
Q13-E B C		OV OV 8.6V	OV OV 8.6V	OV OV 8.5V	0V .70 .12
Q14-E B C			0V .63V .04V		
Q15-E B C			4.05V 4.65V 9.60V	.,	
Q16-E B C		OV OV 6.4V	OV OV 6.4V	0V .62 .02V	0V 0V 6.4V
Q17-E B C			OV OV OV		
Q18-E B C			0V 0V 4.6V		
Q19-E B C			1.60V 2.15V 9.6V		
Q20-E B C			1.0V 1.6V 8.3V		

METERING POINT	REFERENCE	C	CONTROL CURRENT (MA)					
		-2.5	0	+6	+11			
Q21-E B C	Ground		1.0V 1.55V 4.75V					
Q22-E B C			2.95V 3.45V 8.1V					
Q23-E B C			8.7V 8.1V 4.17V					
Q24-E B C			4.62V 5.20V 9.0V					
Q25-E B C			9.6V 9.0V 4.85V					
Q26-E B C		OV OV 4.75V	OV OV 4.75V	5.4V 6.0V 5.4V	5.4V 6.0V 5.4V			
Q27-E B C		0V 0V 9.4V	OV OV 9.4V	.60V .0V	0V .61V .04V			
Q28-E B C		10.0V 9.4V OV	10.0V 9.4V OV	10.0V 9.3V 10.0V	10.0V 9.3V 10.0V			
U5 <b>-4</b> 5		0V 10.0V	0V 10.0V	OV OV	OV OV			
U3-4 5		OV OV	0V 10.0V	OV OV	0V 10.0V			
U <b>4-4</b> 5		0V 10.0V	0V 10.0V	OV OV	OV .16V			
U1-1 2 3 4 5 6 8 9 10 11 12 13		9.8V 10.0V OV 10.0V 9.8V OV 10.0V 10.0V OV	9.8V OV OV 10.0V 9.7V OV 9.8V OV 10.0V OV	0V 10.0V 0V 0V 10.0V 0V 0V 10.0V 10.0V 0V	OV OV 9.9V 9.9V OV OV OV 9.8V OV OV 9.9V			
U2-1 2 3 4 5 6 8 9 10 11 12 13		0V 9.8V 0V 10.0V 0V 6.4V 9.8V 0V 0V 9.8V 5V	9.8V 9.7V OV OV 9.8V 6.8V 9.7V OV 9.7V OV	OV OV 10.0V OV 10.0V OV OV OV 10.0V 10.0V OV 5V	9.8V OV OV 10.0V 9.8V 6.4V OV .5V 10.0V OV .5V			

			<del></del>	
CURRENT (MA)	CONTROL C		REFERENCE	METERING POINT
+6 +11	5 0	-2.5		
6.8V 10.9V 6.2V 6.4V 7.9V 12.0V	5V OV	-4.45 -3.75 -4.35	Pin (Control -)	Q1-E B C
7.9V 12.0V 3.7V 4.2V 9.0V 12.0V	v ov	-4.35 -3.8V -3.35		Q2-E B C
9.0V 8.3V 7.9V 12.1V 11.3V 12.0V	7V OV	-3.35 37 -4.35		Q3-E B C
7.9V 12.0V 6.8V 10.9V		-4.37 -4.45		U5-1 2
9.0V 7.8V 12.1V 12.0V		-3.35 -4.35		U3-1 2
16.8V 24.7V 23.7V		-8.2V -5.2V		U4-1 2
9.0V 7.8V	5V OV OV OV	-3.35 -4.35		U3-1 2 U4-1

#### DC REMOTE CONTROL BOARD 19D424457G4 DC VOLTAGE READINGS

All readings are typical readings made with a 20,000 ohms-per-Volt meter.

METERING POINT	REFERENCE	CONTROL CURRENT (MA)					
		-11	-6	-2.5	0	+6	+11
AR1-2 3 6	Ground				4.7V 4.7V 4.7V		
Q4-E		0V	0V	OV	0V	3.5V	5.5V
B		0V	0V	OV	0V	4.05V	6.0V
C		10.0V	10.0V	10.0V	10.0V	10.0V	10.0V
Q5–E		0V	0V	OV	OV	2.82V	4.9V
B		0V	0V	OV	OV	3.5V	5.5V
C		10.0V	10.0V	10.0V	10.0V	10.0V	10.0V
Q6-E		0V	OV	0V	OV	OV	OV
B		0V	OV	0V	OV	.73V	•74V
C		10.0V	10.0V	10.0V	10.0V	.12V	•10V
Q7-E		OV	OV	OV	OV	OV	OV
B		OV	OV	OV	OV	.68V	.35V
C		8.7V	8.6V	8.7V	8.6V	.09V	8.7V
Q8-E		0V	OV	OV	OV	ov	OV
B		.63V	OV	OV	OV	ov	.64V
C		.02V	OV	.68V	.68V	ov	.03V
Q9-E		0V	OV	OV	OV	OV	OV
B		0V	OV	.69V	.68V	OV	.03V
C		8.8V	8.8V	OV	.08V	8.8V	8.8V
Q10-E		OV	OV	0V	OV	0V	0V
B		OV	.69V	0V	OV	.69V	0V
C		OV	OV	8.8V	8.6V	.09V	.10V
Q11-E		OV	OV	OV	OV	0V	OV
B		.68V	OV	OV	OV	0V	.70V
C		.09V	OV	8.7V	8.6V	.09V	.10V
Q12-E		0V	0V	OV	0V	OV	OV
B		.69V	0V	.69V	0V	.15V	.26V
C		.09V	8.6V	.10V	8.6V	8.6V	8.8V
Q13-E B C					0V 0V 8.6V		
Q14-E B C			-		OV .64V .04V		
Q15-E B C					4.15V 4.75V 9.70V		
Q16-E		OV	OV	OV	OV	OV	OV
B		OV	.63V	OV	OV	.64V	OV
C		6.2V	OV	6.5V	6.4V	.02V	6.2V
Q17-E B C					OV OV OV		
Q18-E B C					OV .18V 4.72V		

ETERING POINT	REFERENCE		CONTROL CURRENT (MA)				
		-11	-6	-2.5	0	+6	+11
Q19-E B C	Ground				1.67V 2.20V 9.60V		
Q20-E B C					1.05V 1.65V 8.30V		
Q21-E B C					1.11V 1.65V 4.12V		
Q22-E B C					2.95V 3.48V 8.2V		
Q23-E B C					8.7V 8.1V 4.1V		
Q24-E B C					4.6V 5.2V 8.9V		
Q25-E B C					9.6V 8.9V 4.85V		
Q26-E B C		0V 0V 4.2V	OV OV 4.1V	OV OV 4.15V	OV OV 4.12V	5.2V 5.7V 5.2V	5.2V 5.8V 5.2V
Q27-E B C		0V 0V 9.5V	OV OV 9.5V	OV OV 9.6V	OV OV 9.4V	0V .64V .06V	0V .62V .05V
Q28-E B C		10.0V 9.5V OV	10.0V 9.5V OV	10.0V 9.6V OV	10.0V 9.4V OV	10.0V 9.4V 10.0V	10.0V 9.4V 10.0V
U5-4 5		OV OV	OV OV	0V 10.0V	0V 10.0V	OV OV	OV OV
U3-4 5		0V 10.0V	ov ov	OV OV	0V 10.0V	OV OV	0V 10.0V
U4-4 5		0V 10.0V	0V 10.0V	0V 10.0V	OV 10.0V	OV OV	OV OV
U1-1 2 3 4 5 6 8 9 10 11 12 13		0V 0V 9.6V 0V 0V 9.8V 0V 9.9V 0V 0V 9.6V	0V 10.0V 0V 0V 10.0V 9.8V 0V 10.0V 10.0V 10.0V	10.0V 10.0V 0V 0V 10.0V 9.9V 0V 10.0V 10.0V 0V	9.8V OV OV 10.0V 9.8V OV 9.8V OV 10.0V OV	0V 10.0V 0V 0V 10.0V 0V 0V 0V 10.0V 10.0V 0V	OV OV 9.6V 10.0V OV OV OV 9.9V OV OV OV OV

METERING POINT	REFERENCE			CONTROL	CURRENT	(MA)	
		-11	-6	-2.5	0	+6	+11
U2-1 2 3 4 5 6 8 9 10 11 12 13	Ground	9.9V OV OV 8.3V 9.9V 6.2V 9.8V OV 9.0V OV .5V	OV OV 9.7V OV 9.0V OV OV 9.8V OV 9.0V OV 5.5V	0V 10.0V 0V 10.0V 0V 0V 6.5V 9.9V 0V 0V 10.0V 4.4V	9.8V 9.8V OV OV 9.8V 6.4V 9.8V OV OV 9.8V 6.5V	OV OV 9.7V 4.2V 4.7V OV OV 10.0V 4.7V OV .50V	9.9V OV OV 7.9V 9.9V 6.3V OV OV 8.0V OV .5V
Q1-E B C Q2-E B C Q3-E B C Q29-1 2 Q30-1 2	Pin (Control -)	-13.2V -12.6V -12.1V -12.1V -11.6V -12.1V -12.1V -12.2V -13.2V -12.1V -12.1V -12.1V -12.7V -12.7V -70V	-9.0V -8.4V -7.9V -7.9V -7.3V -6.8V -4.8V -7.9V -8.9V -6.8V -7.9V -6.8V -7.9V -16.0V 45V	-4.53V -3.85V -4.48V -4.48V -3.90V -3.43V -3.45V -3.88V -4.47V -4.52V -3.43V -4.47V -8.4V 40V	OV OV OV OV OV OV OV OV OV OV	7.0V 6.2V 8.0V 8.0V 9.1V 9.0V 8.4V 8.0V 6.9V 9.0V 8.0V 17V 15.7V	11.1V 6.4V 12.3V 12.3V 4.5V 12.3V 12.3V 12.3V 11.5V 12.2V 4.1V 3.7V 4.1V 25.4V 24.0V

### DC REMOTE CONTROL BOARD VOLTAGE READINGS

8 Issue 2

# REMOTE CONTROL BOARD 19D424457G5, G8 & G9 DC VOLTAGE READINGS

All readings are typical readings made with a 20,000 ohms-per-Volt meter.

ERING DINT	REFERENCE	CONT	ROL CURRE	NT (MA)
		-2.5	0	+6
3 6	Ground		4.75V 4.75V 4.75V	
24 – E B C		OV OV 10.0V	OV OV 10.0V	9.1V 9.6V 10.0V
95-E B C		OV OV 10.0V	0V 0V 10.0V	8.3V 9.1V 10.0V
96-E B C		OV OV 10.0V	OV OV 10.0V	0V .80V 10.00V
.2-E B C		OV .69V .08V	0V 0V 8.6V	OV OV 8.7V
.4-Е В С			OV •64V OV	-
.5-E B C		9.80V	4.15V 4.72V 9.80V	
.6-E B C		OV OV 10.0V	0V 0V 10.0V	OV .63V OV
17-Е В С			OV OV OV	
L8-E B C			OV OV 4.7V	
.9 <b>–</b> E B C			1.50V 2.05V 9.80V	
80 <b>–</b> Е В С			.96V 1.50V 8.30V	
21-E B C			1.04V 1.55V 4.45V	
22-E B C			2.98V 3.50V 8.20V	
23-E B C			4.20V 8.20V 8.80V	
24-E B C			4.65V 5.20V 9.00V	

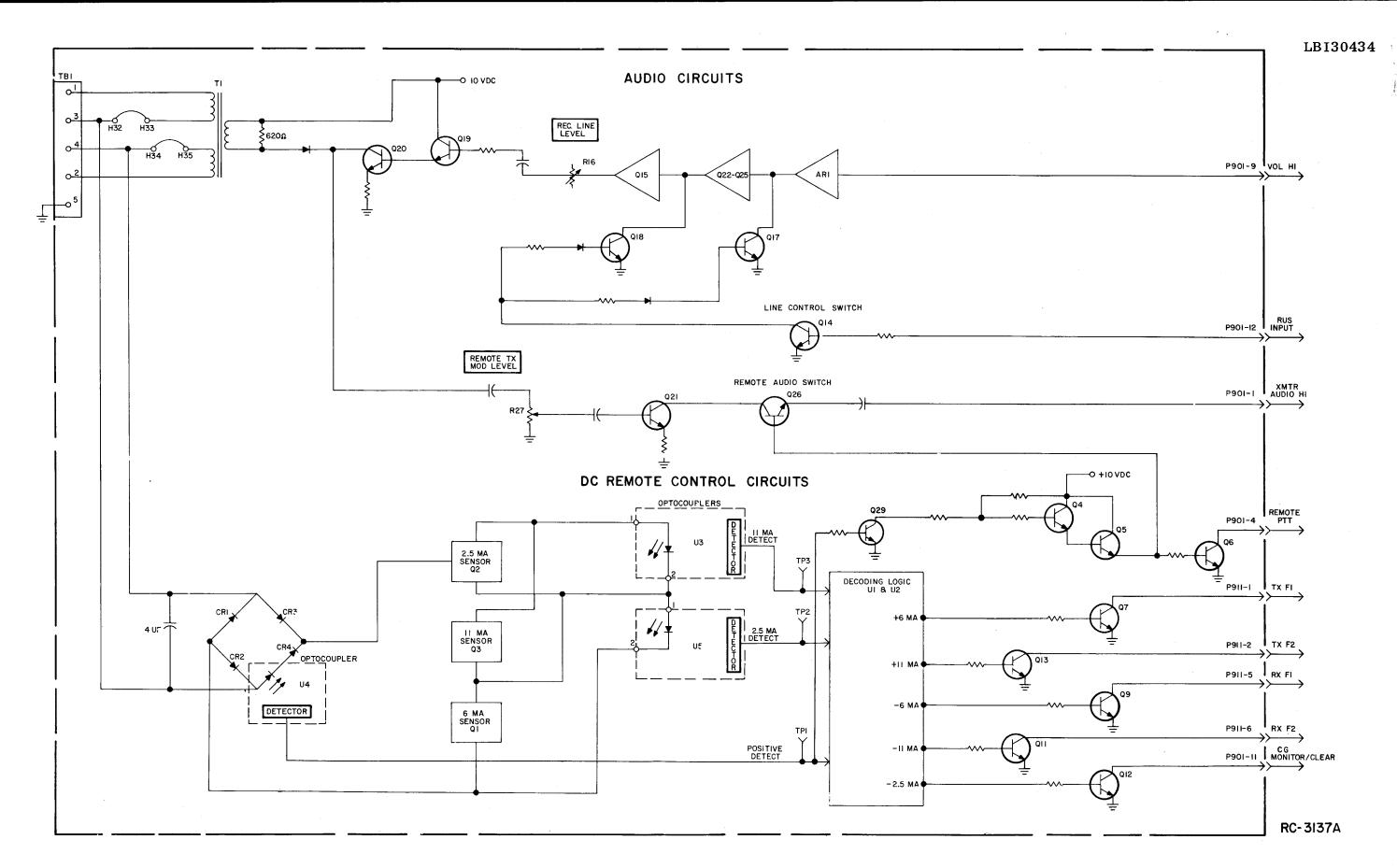
METERING POINT	REFERENCE	CONT	ROL CURRE	ENT (MA)
		-2.5	0	+6
Q25-E B C			9.70V 9.00V 4.90V	
Q26-E		OV	OV	4.8V
B		OV	OV	5.4V
C		4.45V	4.45V	4.8V
U5 <b>-4</b>		0V	0V	OV
5		10.0V	10.0V	OV
U3-4		OV	OV	OV
5		OV	10.0V	OV
U4-4		0V	OV	OV
5		10.0V	10.0V	OV
U2-1 2 3 4 5 6 8 9 10 11 12 13	Ground	0V 9.8V 0V 10.0V 0V 10.0V 9.8V 0V 9.8V .5V	9.9V 9.8V OV OV 9.9V 10.0V 9.8V OV OV 9.9V 5.5V	OV OV 9.9V 2.25V 6.8V OV OV 10.0V 6.4V OV .5V
Q1-E B C	Pin (Control -)	-4.6V -3.85V -4.5V	OV OV OV	7.4V 6.2V 8.5V
Q2-E		-4.5V	OV	8.4V
B		-3.9V	OV	3.7V
C		-3.45V	OV	9.6V
U5-1		-4.5V	ov	8.5V
2		-4.5V	ov	7.4V
U3-1		-3.45V	ov	9.5V
2		-4.45V	ov	8.4V
U4-1		-8.4V	OV	18V
2		40V	OV	16.5V

#### LOGIC CIRCUIT TRUTH TABLE

Voltage measurements at the test points referenced to ground in the following tables are approximately equal to 10 VDC for the "1" state and zero voltage for the "0" state. The logic functions associated with each control line current vary with the individual Remote Board used. Not all functions are present on every board.

#### REMOTE CONTROL BOARDS 19D424457G1-G5

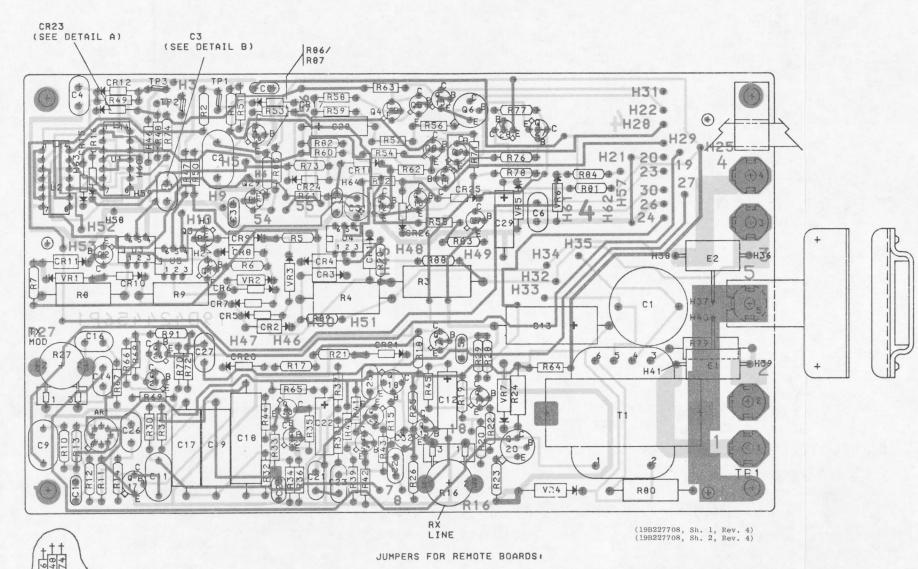
Control Line		TEST POIN	г
Current	TP1	TP2	TP3
+11 mA	"0"	"0"	"1"
+6 mA	"0"	"0"	"0"
O mA	"1"	"1"	"1"
-2.5 mA	"1"	"1"	''0''
-6 mA	"1"	"0"	"0"
-11 mA	"1"	"0"	"1"



### SYSTEM DIAGRAM

DC REMOTE CONTROL





	GROUP 1	
FROM	ТО	WIRE
H1	H2	DA
НЗ	H4	DA
H7	H8	DA
H10	H55	DA
H32	H33	DA
H34	H35	DA
H44	H45	DA
H46	H47	DA
H61	H62	DA

	GROUP 2	
FROM	ТО	WIRE
H7	H8	DA
H9	H10	DA
H32	H33	DA
H34	H35	DA
H52	H53	DA
H54	H55	DA
1134	1100	J.

FROM	ТО	WIRE
19	H10	DA
132	H33	DA
134	H35	DA
154	H55	DA

FROM	ТО	WIRE
H9	H10	DA
H32	H33	DA
H34	H35	DA
H54	H55	LA
H53	H58	DA
H59	H60	DA

(19D424458, Rev. 7)

LEAD IDENTIFICATION FOR Q6, Q17, Q18, Q20



TRIANGULAR TOP VIEW NOTF: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

FROM	ТО	WIRE	
P901-1	H27	CONDUCTOR	7145310P1
P901-2	H26	SHIELD	
P901-3	H21	SF24-BK	
P901-4	H22	SF24-0	
P901-5	H25	SF24-R	
P901-6	H57	SF24-W-G	
P901-7			
P901-8			
P901-9	H19	CONDUCTOR	7145310P1
P901-10	H20	SHIELD	
P901-11	H23	SF2	4-G
P901-12	H24	SF2	4-BL

P911

P901

0 6

2 3

FROM	TO	WIRE
P911-1	H30	SF24-W
P911-2	H31	SF24-BR
P911-3		
P911-4		
P911-5	H28	SF24-V
P911-6	H29	SF24-Y

RUNS ON SOLDER SIDE RUNS ON BOTH SIDES

RUNS ON COMPONENT SIDE

### OUTLINE DIAGRAM

DC REMOTE CONTROL BOARDS 19D424457G1-G9

10

DETAIL "B" ASSEMBLY OF C3 IN GROUP 8,9 ONLY

CR23

DETAIL A

POLARITY FOR

GROUP 8,9 ONLY

CR23 IN

Issue 5

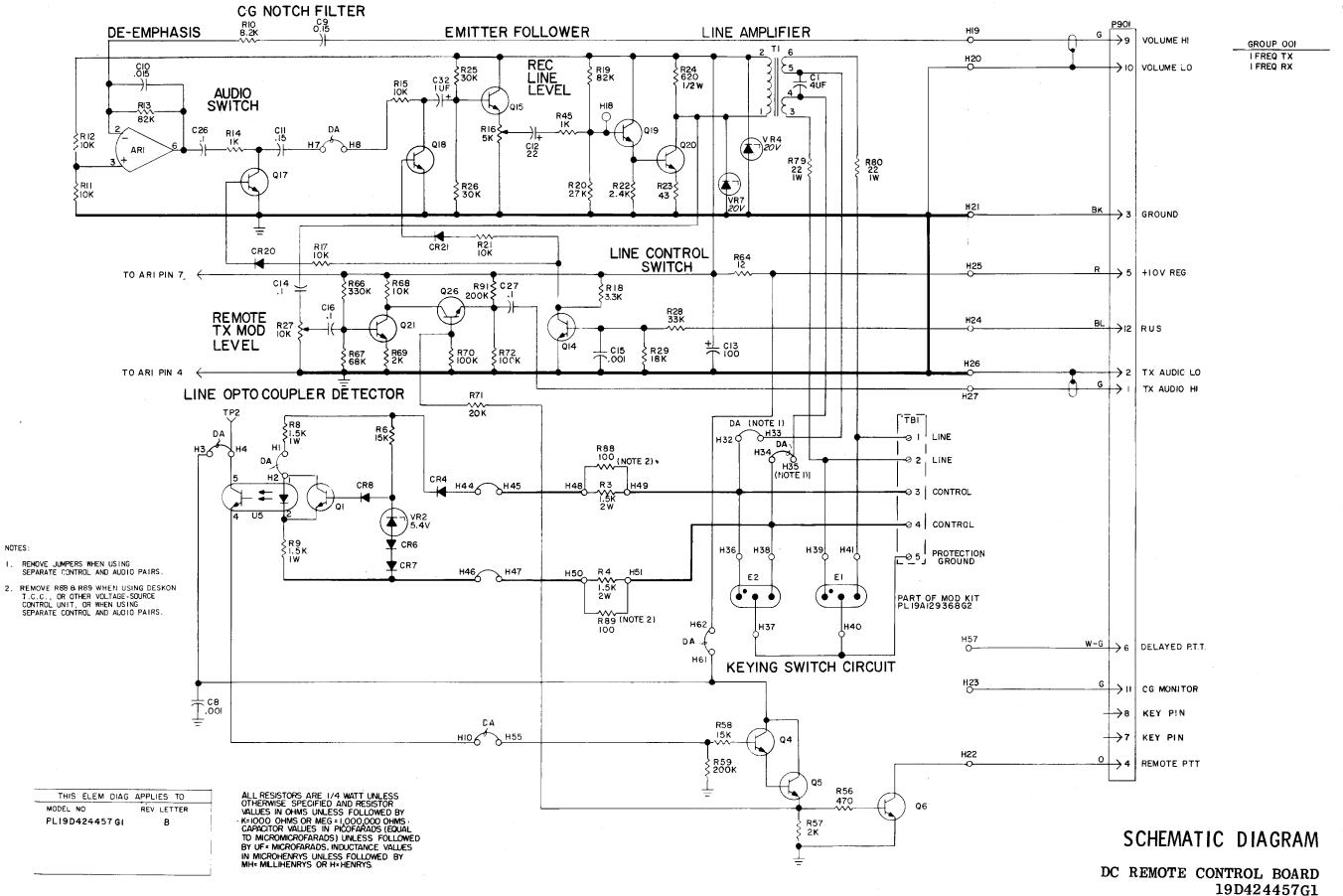
LEAD IDENTIFICATION FOR Q1-Q5, Q7-Q16, Q19, Q21-Q29

IN-LINE

NOTE: LEAD ARRANGEMENT, AND NOT

TOP VIEW

CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.



#### PARTS LIST

LB130568B

DC REMOTE CONTROL BOARD 19D424457G1

SYMBOL	GE PART NO.	DESCRIPTION
ARl	19A116297P2	Integrated circuit, linear: With TO99 Package, operational amplifier.
C1	7486445P5	Electrolytic, non polarized: 4 µf +100% -10%, 150 VDCW.
C8	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C9	19A116080P108	Polyester: 0.15 µf ±10%, 50 VDCW.
C10	19A116080P102	Polyester: 0.015 μf ±10%, 50 VDCW.
C11	19A116080P8	Polyester: 0.15 μf ±20%, 50 VDCW.
C12	5496267P10	Tantalum: 22 $\mu$ f $\pm$ 20%, 15 VDCW; sim to Sprague Type 150D.
C13	19A115680P7	Electrolytic: 100 µf +150% -10%, 15 VDCW; sim to Mallory Type TTX.
C14	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C15	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C16	19All6080Pl07	Polyester: 0.1 µf ±10%, 50 VDCW.
C26	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C27	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C32	19A134202P14	Tantalum: 1 μf ±20%, 35 VDCW.
		-, DIODES AND RECTIFIERS
CR4	4037822P2	Silicon, 1000 mA, 600 PIV.
CR6 and CR7	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
CR8	4037822P2	Silicon, 1000 mA, 600 PIV.
CR20 and	19All5250Pl	Silicon, fast recovery, 225 mA, 50 PIV.
CR21		
P901		Connector, Includes:
	19A116659P21	Shell.
	19A116781P5	Contact, electrical: wire range No. 18-24 AWG; sim to Molex 08-50-0106. (Quantity 2).
	19A116781P6	Contact, electrical: wire range No. 22-26 AWG; sim to Molex 08-50-0108. (Quantity 8).
	19B209519P1	Polarity tab.
Q1	19A115910P1	Silicon, NPN; sim to Type 2N3904.
Q4 and Q5	19All5910Pl	Silicon, NPN; sim to Type 2N3904.
<b>ų</b> 5 Q6	19A115300P2	Silicon, NPN; sim to Type 2N3053.
Q14	19A115910P1	Silicon, NPN; sim to Type 2N3904.
Q15	19A116774P1	Silicon, NPN; sim to Type 2N5210.
Q17 and	19A129184P1	Silicon, NPN.
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<b>Q</b> 19	19Al16774Pl	Silicon, NPN; sim to Type 2N5210.
Q20	19A115300P4	Silicon, NPN.
221	19Al16774Pl	Silicon, NPN; sim to Type 2N5210.
226	19A116774P1	Silicon, NPN; sim to Type 2N5210.
		RESISTORS
R3	3R79P152K	Composition: 1.5K ohms ±10%, 2 w.

SYMBOL	GE PART NO.	DESCRIPTION
R6	3R152P153J	Composition: 15K ohms ±5%, 1/4 w.
R8 and R9	3R78P152J	Composition: 1.5K ohms ±5%, 1 w.
R10	3R152P822J	Composition: 8.2K ohms ±5%, 1/4 w.
R11 and R12	3R152P103J	Composition: 10K ohms ±5%, 1/4 w.
R13	3R152P823J	Composition: 82K ohms ±5%, 1/4 w.
R14	3R152P102J	Composition: 1K ohms ±5%, 1/4 w.
R15	3R152P103J	Composition: 10K ohms ±5%, 1/4 w.
R16	19B209358P5	Variable, carbon film: approx 200 to 5K ohms ±20%, 0.25 w; sim to CTS Type U-201.
R17	3R152P103J	Composition: 10K ohms ±5%, 1/4 w.
R18*	3R152P332J	Composition: 3.3K ohms ±5%, 1/4 w.  Earlier than REV A:
	3R152P103J	Composition: 10K ohms ±5%, 1/4 w.
R19	3R152P823J	Composition: 82K ohms ±5%, 1/4 w.
R20	3R152P273J	Composition: 27K ohms ±5%, 1/4 w.
R21	3R152P103J	Composition: 10K ohms ±5%, 1/4 w.
R22	3R152P242J	Composition: 2.4K ohms ±5%, 1/4 w.
R23	3R152P430J	Composition: 43 ohms ±5%, 1/4 w.
R24	3R77P621J	Composition: 620 ohms ±5%, 1/2 w.
R25 and R26	3R152P303J	Composition: 30% ohms ±5%, 1/4 w.
R27	19B209358P6	Variable, carbon film: approx 300 to 10K ohms ±20%, 0.25 w; sim to CTS Type U-201.
R28	3R152P333J	Composition: 33K ohms ±5%, 1/4 w.
R29	3R152P183J	Composition: 18K ohms ±5%, 1/4 w.
R45	3R152P102J	Composition: 1K ohms ±5%, 1/4 w.
R56	3R152P471J	Composition: 470 ohms ±5%, 1/4 w.
R57	3R152P202J	Composition: 2K ohms ±5%, 1/4 w.
R58	3R152P153J	Composition: 15K ohms ±5%, 1/4 w.
R59	3R152P204J	Composition: 200K ohms ±5%, 1/4 w.
R64	3R152P120J	Composition: 12 ohms ±5%, 1/4 w.
R66	3R152P334J	Composition: 330K ohms ±5%, 1/4 w.
R67	3R152P683J	Composition: 68K ohms ±5%, 1/4 w.
R68	3R152P103J	Composition: 10K ohms ±5%, 1/4 w.
R69	3R152P202J	Composition: 2K ohms ±5%, 1/4 w.
R70	3R152P104J	Composition: 100K ohms ±5%, 1/4 w.
R71	3R152P203J	Composition: 20K ohms ±5%, 1/4 w.
R72	3R152P104J	Composition: 100K ohms ±5%, 1/4 w.
R79 and R80	19Al16310P5	Composition: 22 ohms ±5%, 1.0 w; sim to Allen- Bradley Type GB.
R88 and R89	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
R91*	3R152P204J	Composition: 200K ohms ±5%, 1/4 w. Added by REV B.
т1	19A134368P1	Audio freq: 300 to 6000 Hz, Pri: 27 ohms ±15%, Sec No. 1 & 2: 16.5 ohms ±15%.
TB1	19A116667P3	TERMINAL BOARDS Nut, plate: sim to Malco X0-2879. (Quantity 5).
		TOTAL
TP2	19B211379P1	Spring (Test Point)
U5	19A116908P1	Optoelectronic coupler: Dual In Line 6 Pin Mini

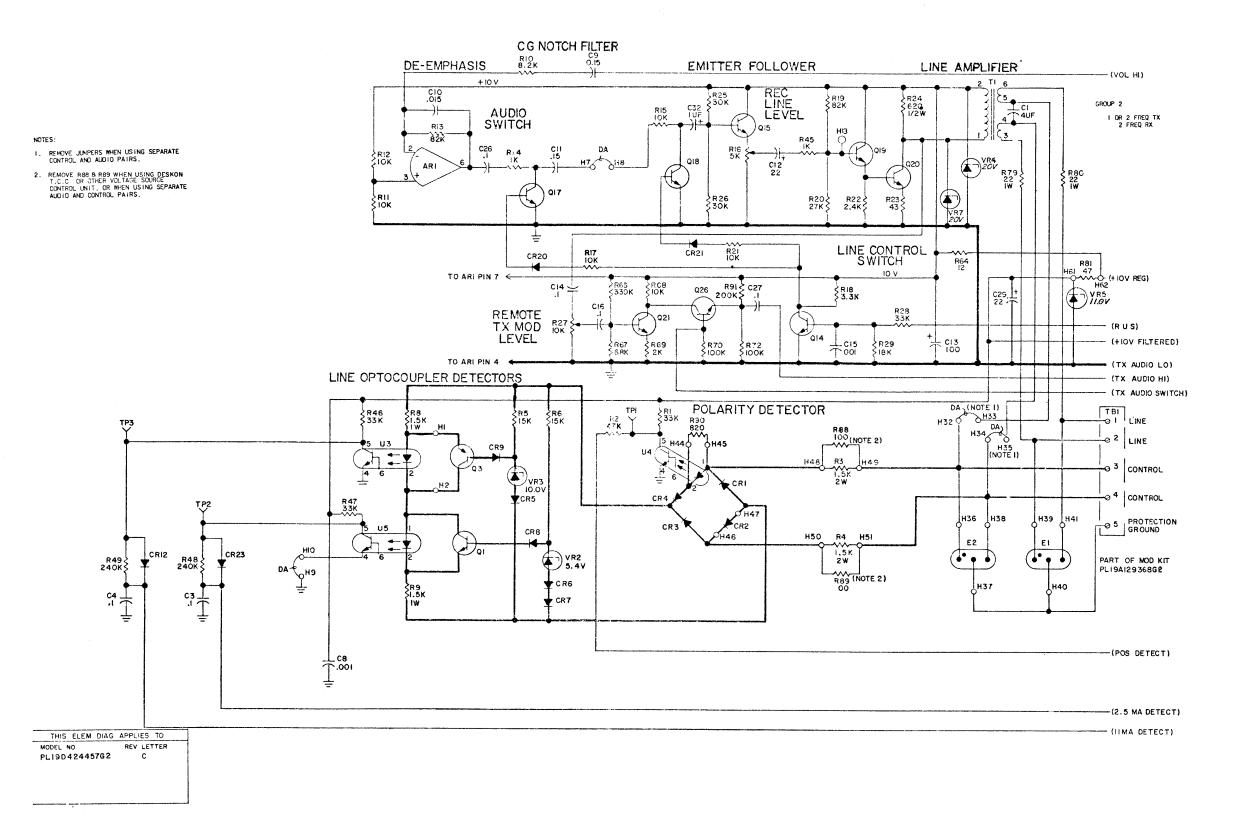
		DESCRIPTION
- 1		
VR2	4036887P5	VOLTAGE REGULATORS
VR4		Silicon, Zener.
	19A116325P6	Silicon, Zener; sim to Type 1N5357.
VR7	19A116325P6	Silicon, Zener; sim to Type 1N5357.
		miscellaneous
	4036555P1	Insulator, washer: nylon. (Used with Q6, Q20)
	19A116155P1	Insulator. (Used with ARI).
	4029851P14	Clip loop. (Located by TB1-4).
	19C3O7O38P11	Nut, push-on. (Secures clip loop at TB1-4).
	19A121457P1	Clamp. (Part of TBl strain relief).
	19B219835P1	Support. (Part of TB1 strain relief clamp and support).
	19B201074P208	Tap screw, Phillips POZIDRIV®: No. 4-40 x 1/2. (Secures TBl strain relief clamp and support).
	19B201074P304	Tap screw, Phillips POZIDRIV®: No. 6-32 x 1/4. (Secures TB1-1 thru 4).
	19B201074P305	Tap screw, Phillips POZIDRIV <sup>®</sup> : No. 6-32 x 5/16 (Secures TB1-5).
	19D424457G7	Cable assembly, (Includes P901).

#### PRODUCTION CHANGES

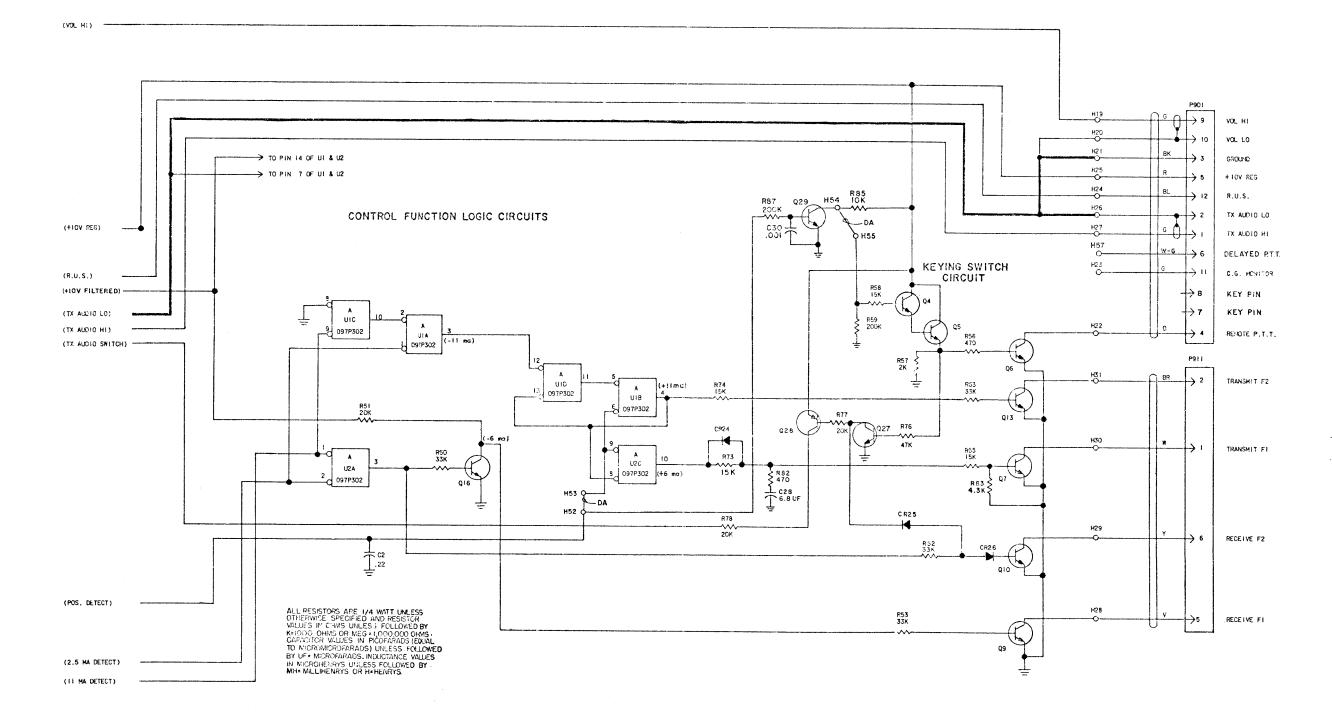
Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - To improve audio squelching action on input to line amplifier. Changed value of R18.

REV. B - To reduce distortion of Mic pre-amp. Added R91.



(19D424454, Sh. 1, Rev. 3)



(19D424454, Sh. 2, Rev. 2)

SCHEMATIC DIAGRAM

DC REMOTE CONTROL BOARD 19D424457G2

Issue 4

13

PARTS LIST

LB130569C

DC REMOTE CONTROL BOARD 19D424457G2

SYMBOL GE PART NO. DESCRIPTION AR1 Integrated circuit, linear; With TO99 Package, 19A116297P2 Electrolytic, non polarized: 4  $\mu$ f +100% -10%, 150 VDCW. 7486445P5 Polyester: 0.22 µf ±20%, 50 VDCW. C2 19A116080P9 C3A 19A143477P26 Polyester: 0.1 µf ±20%, 50 VDCW. C4 Polyester: 0.1 \( \mu f \pm 20\%, 50 \) VDCW. 19A143477P26 19A700233P7 Ceramic disc: 1000 pf ±20%, 50 VDCW Polyester: 0.15 µf ±10%, 50 VDCW. C9 19A116080P108 C10 Polvester: 0.015 µf ±10%, 50 VDCW. 19A700234P8 C11 Polyester: 0.15  $\mu$ f  $\pm$ 20%, 50 VDCW. 19A116080P8 C12 5496267P10 Tantalum: 22  $\mu$ f  $\pm$ 20%, 15 VDCW; sim to Sprague Electrolytic: 100  $\mu$ f +150% -10%, 15 VDCW; sim C13 19A115680P7 19A143477P27 Polyester: 0.1  $\mu$ f  $\pm$ 10%, 50 VDCW. 19A700233P7 Ceramic disc: 1000 pf ±20%, 50 VDCW. C15 Polyester: 0.1 \( \mu f \pm 10\% \), 50 VDCW. C16 19A143477P27 C26 Polyester: 0.1 \( \mu f \pm 20\%\), 50 VDCW. 19A143477P26 C27 19A143477P27 Polyester: 0.1 µf ±10%, 50 VDCW. Tantalum: 6.8  $\mu f$   $\pm 20\%$  , 35 VDCW; sim to Sprague Type 150D. C28 5496267P18 Tantalum: 22  $\mu$ f  $\pm 20\%$ , 15 VDCW; sim to Sprague Type 150D. C29 5496267P10 Ceramic disc: 1000 pf ±20%, 50 VDCw. C30 19A700233P7 C32 19A701534P4 Tantalum: 1 µf ±20%, 35 VDCW. CR1 thru CR4 4037822P2 Silicon, 1000 mA, 600 PIV. CR5 thru CR7 19A115250P1 Silicon, fast recovery, 225 mA, 50 PIV. CR8 and CR9 Silicon, 1000 mA, 600 PIV. 4037822P2 Silicon, fast recovery, 225 mA, 50 PIV. CR12 19A115250P1 CR20 19A115250P1 Silicon, fast recovery, 225 mA, 50 PIV. and CR21 CR23 and CR24 19A115250P1 Silicon, fast recovery, 225 mA, 50 PIV. Silicon, fast recovery, 225 mA, 50 PIV. Added by REV C. CR25\* 19A115250P1 and CR26\* 19A116683P1 Protector. (Part of 19A129368G2 Kit).

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL
			1
P901		Connector. Includes:	£19
	19A116659P21	Shell.	R20 R21
	19A116781P5	Contact, electrical: wire range No. 18-24 AWG; sim to Molex 08-50-0106. (Quantity 2).	R22
	19A116781P6	Contact, electrical: wire range No. 22-26 AWG; sim to Molex 08-50-0108. (Quantity 8).	R23
	19B209519P1	Polarity tab. (Quantity 2).	R24
P911		Connector. Includes:	R25 and
	19A116659P80	Shell.	R26
	19Al16781P6	Contact, electrical: wire range No. 22-26 AWG; sim to Molex 08-50-0108. (Quantity 4).	R28
		TRANSISTORS	R29
Q1	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R4.5
Q3	19A115852P1	Silicon, PNP; sim to Type 2N3906.	R46 and
Q4 and Q5	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R47
Q6.	19A115300P2	Silicon, NPN; sim to Type 2N3053.	and R49
Q7	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R50
Q9 and	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R51 R52
Q10 Q13	19A115910P1	Silicon, NPN; sim to Type 2N3904.	and R53
and Q14		, ,	R55
Q15 and	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R56
Q16 Q17 and Q18	19A129184P1	Silicon, NPN.	F58
Q19	19A116774P1	Silicon, NPN; sim to Type 2N5210.	F59
Q20	19A115300P4	Silicon, NPN.	F63
Q21	19A116774P1	Silicon, NPN; sim to Type 2N5210.	F64
Q26	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R67
Q27	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R68
Q28	19A115852P1	Silicon, PNP; sim to Type 2N3906.	R69
Q29	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R70
		RESISTORS	R72
R1	19A700019P55	Deposited carbon: 33K ohms ±5%, 1/4 w.	R73 and
R2	19A700019P57	Deposited carbon: 47K ohms ±5%, 1/4 w.	R74
R3 and R4	19A700111P67	Composition: 1.5K ohms ±5%, 2 w.	R76
R5 and R6	19A700019P51	Deposited carbon: 15K ohms ±5%, 1/4 w.	and R78 R79
R8 and R9	19A700112P67	Composition: 1.5K ohms ±5%, 1 w.	and R80
R10	19A700019P48	Deposited carbon: 8.2K ohms ±5%, 1/4 w.	R82
R11 and R12	19A700019P49	Deposited carbon: 10K ohms ±5%, 1/4 w.	R83
R13	19A700019P60	Deposited carbon: 82K ohms ±5%, 1/4 w.	R87
R14	19A700019P37	Deposited carbon: 1K ohms ±5%, 1/4 w.	R88
R15A	19A700019P49	Deposited carbon: 10K ohms ±5%, 1/4 w.	and R89
R16	19B209358P5	Variable, carbon film: approx 200 to 5K ohms ±20%, 0.25 w; sim to CTS Type U-201.	R90 R91*
R17A	19A700019P49	Deposited carbon: 10K ohms ±5%, 1/4 w.	
R18*	19A700019P43	Deposited carbon: 3.3K ohms ±5%, 1/4 w.	
		Earlier than REV A:	1 [

Composition: 10K ohms ±5%, 1/4 w.

3R152P103J

GE PART NO.

19A700019P60

19A700019P54

19A700019P49

19A700019P41

19A143400P20

19A143400P54

19B209358P6

19A700019P55

19A700019P52

19A700019**P**37

19A700019P55

19A143400P65

19A700019P55

19A143400P52

19A700019P55

19A700019P51

19A700019P33

19A143400P40

19A700019P51

19A143400P64

19A700019P55

19A700019P14

19A700019P67

19A700019P59

19A700019P49

19A143400P40

19A700019P61

19A700019P61

19A700019P51

19A700019P57

19A143400P52

19A116310P5

19A700019P21

19A700019P33

19A143400P44

19A700019P49

19A143400P64

19A700019P25

19A700019P36

19A143400P64

3R7P621J

DESCRIPTION

Deposited carbon: 82K ohms ±5%, 1/4 w.

Deposited carbon: 27K ohms ±5%, 1/4 w.

Deposited carbon: 10K ohms ±5%, 1/4 w.

Deposited carbon: 2.2K ohms ±5%, 1/4 w.

Deposited carbon: 43 ohms ±5%, 1/4 w.

Deposited carbon: 30K ohms ±5%, 1/4 w.

Deposited carbon: 33K ohms ±5%, 1/4 w.

Deposited carbon: 18K ohms ±5%, 1/4 w.

Deposited carbon: 1K ohms ±5%, 1/4 w.

Deposited carbon: 33K ohms ±5%, 1/4 w.

Deposited carbon: 240K ohms +5%, 1/4 w.

Deposited carbon: 33K ohms ±5%, 1/4 w.

Deposited carbon: 20K ohms ±5%, 1/4 w.

Deposited carbon: 33K ohms ±5%, 1/4 w.

Deposited carbon: 15K ohms ±5%, 1/4 w.

Deposited carbon: 470 ohms +5%, 1/4 w.

Deposited carbon: 2K ohms ±5%, 1/4 w.

Deposited carbon: 15K ohms ±5%, 1/4 w.

Deposited carbon: 200K ohms ±5%, 1/4 w.

Deposited carbon: 33K ohms ±5%, 1/4 w.

Deposited carbon: 12 ohms ±5%, 1/4 w.

Deposited carbon: 68K ohms ±5%, 1/4 w.

Deposited carbon: 10K ohms ±5%, 1/4 w.

Deposited carbon: 2K ohms ±5%, 1/4 w.

Deposited carbon: 100K ohms ±5%, 1/4 w

Deposited carbon: 100K ohms ±5%, 1/4 w.

Deposited carbon: 15K ohms ±5%, 1/4 w.

Deposited carbon: 47K ohms ±5%, 1/4 w.

Deposited carbon: 20K ohms ±5%, 1/4 w.

Deposited carbon: 47 ohms ±5%, 1/4 w.

Deposited carbon: 470 ohms ±5%, 1/4 w.

Deposited carbon: 4.3K ohms  $\pm 5\%$ , 1/4 w Deposited carbon: 10K ohms  $\pm 5\%$ , 1/4 w.

Deposited carbon: 200K ohms ±5%, 1/4 w.

Deposited carbon: 100 ohms ±5%, 1/4 w.

Deposited carbon: 820 ohms ±5%, 1/4 w.

Deposited carbon: 200K ohms ±5%, 1/4 w. Added REV B.

Composition: 22 ohms  $\pm 5\%$ , 1.0 w; sim to Allen-Bradley Type GB.

Variable, carbon film: approx 300 to 10K ohms  $\pm 20\%$ , 0.25 w; sim to CTS Type U-201.

Composition: 620 ohms ±5%, 1/2 w.

SYMBOL	GE PART NO.	DESCRIPTION
Tl	19A134368P1	Audio freq: 300 to 6000 Hz, Pri: 27 ohms ±15%,
		Sec No. 1: 16.5 ohms ±15%, Sec No. 2: 16.5 ohms ±15%.
		TERMINAL BOARDS
TB1	19A116667P3	Nut, plate: sim to Malco X0-2879. (Quantity 5)
		TEST POINTS
TP1 thru TP3	19B211379P1	Spring (Test Point).
U1	19A134097P302	INTEGRATED CIRCUITS
and U2	198134097F302	Digital (C MOS SERIES): QUAD 2- Input Nor Gate; sim to Vendor Type No. 4001.
U3 thru U5	19A116908P1	Optoelectronic coupler: Dual In Line 6 Pin Mini Dip Package; sim to TI TlLl12.
VR2	4036887P5	Silicon, Zener.
VR3 VR4	4036887P11 19A116325P6	Silicon, Zener. Silicon, Zener; sim to Type 1N5357.
VR5	4036887P8	Silicon, Zener.
VR7	19A116325P6	Silicon, Zener; sim to Type 1N5357.
		MISCELLANEOUS
	4036555Pl	Insulator, washer: nylon. (Used with Q6, Q20).
	19A116155P1	Insulator. (Used with AR1).
	4029851 <b>P14</b>	Clip loop. (Located by TB1-4).
	19C307038P11	Nut, push-on. (Secures clip loop at TB1-4).
	19A121457P1	Clamp. (Part of TB1 strain relief).
	19B219835P1	Support. (Part of TBl strain relief clamp and support).
	19B201074P208	Tap screw, Phillips POZIDRIV®: No. 4-40 x 1/2. (Secures TBl strain relief clamp and support).
	19B201074P304 19B201074P305	Tap screw, Phillips POZIDRIV®: No. 6-32 x 1/4. (Secures TB1-1 thru 4).  Tap screw, Phillips POZIDRIV®: No. 6-32 x 5/16.
	1982010742305	(Secures TB1-5).
	19D424457G6	Cable assembly. (Includes P911).
	19D424457G7	Cable assembly. (Includes P901).

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

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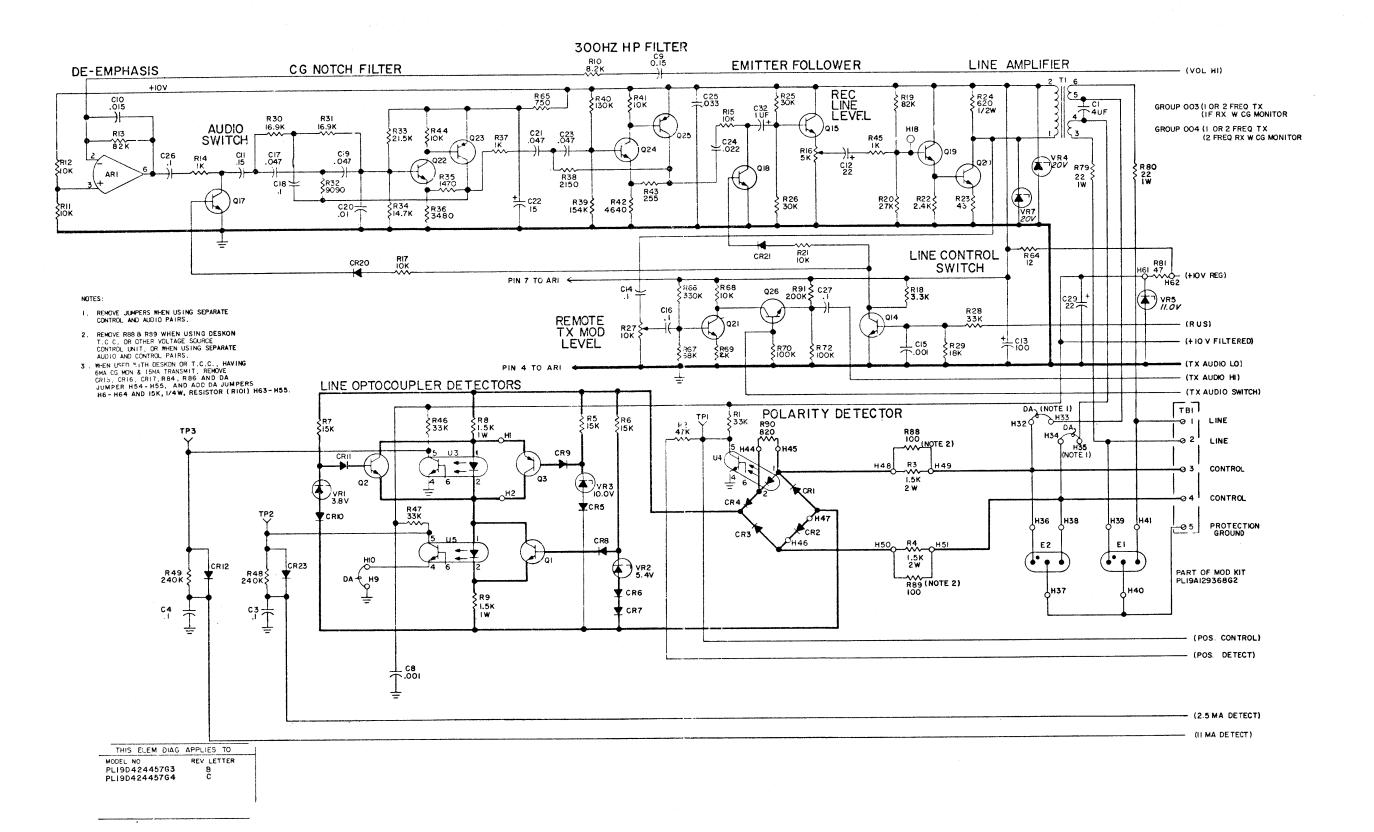
### **PRODUCTION CHANGES**

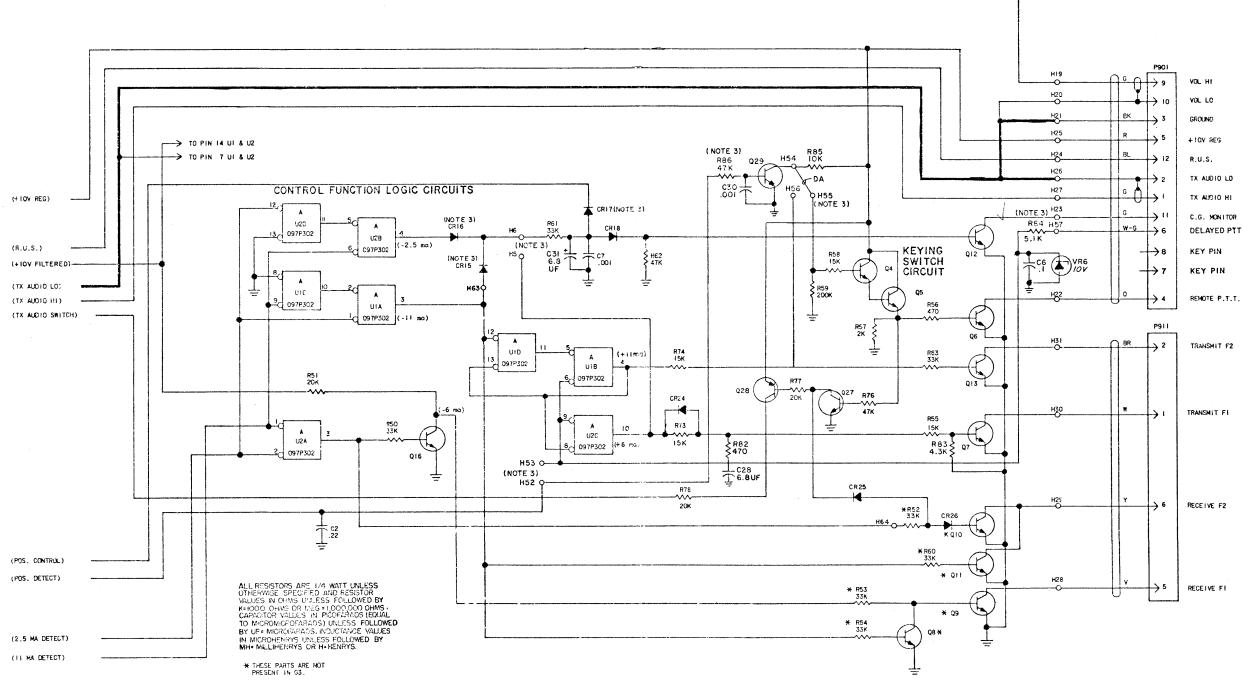
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 $\mbox{REV. A}$  - To improve audio squelching action on input to line amplifier. Changed value of  $\mbox{R18.}$ 

REV. B - To reduce distortion of Mic pre-amp. Added R91.

REV. B - To prevent two oscillators being selected at the same time during transmit condition. Added CR25 and CR26.





(19D424455, Sh. 2, Rev. 3)

SCHEMATIC DIAGRAM

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DC REMOTE CONTROL BOARD 19D424457G3 & G4

Issue 4

(19D424455, Sh. 1, Rev. 4)

#### PARTS LIST

LB130570C

DC REMOTE CONTROL BOARD 19D424457G3 1 FREQ CG MONITOR

SYMBOL	GE PART NO.	DESCRIPTION
AR1 19	A116297P2	Integrated circuit, linear: With TO99 Package, operational amplifier.
21 74	86445P5	Electrolytic, non polarized: 4 $\mu\text{f}$ +100% -10%, 150 VDCW.
22 19	A116080P9	Polyester: 0.22 µf ±20%, 50 VDCW.
3A 19	0A143477P26	Polyester: 0.1 μf ±20%, 50 VDCW.
4 19	A143477P26	Polyester: 0.1 µf ±20%, 50 VDCW.
6 19	0A143477P26	Polyester: 0.1 µf ±20%, 50 VDCW.
7 19 ind :8	9A700233P7	Ceramic disc: 1000 pf ±20%, 50 VDCW.
c9 19	0A116080P108	Polyester: 0.15 $\mu$ f ±10%, 50 VDCW.
210 19	9A700234P8	Polyester: 0.015 $\mu$ f $\pm$ 10%, 50 VDCW.
:11 15	9A116080P8	Polyester: 0.15 $\mu$ f ±20%, 50 VDCW.
54	196267P10	Tantalum: 22 $\mu f$ ±20%, 15 VDCW; sim to Sprague Type 150D.
C13 19	9A115680P7	Electrolytic: 100 $\mu$ f +150% -10%, 15 VDCW; sim to Mallory Type TTX.
C14 1	9A143477P27	Polyester: 0.1 μf ±10%, 50 VDCw.
C15 1	9A700233P7	Ceramic disc: 1000 pf ±20%, 50 VDCW.
C16 1	9A143477P27	Polyester: 0.1 µf ±10%, 50 VDCW.
	9C300075P47001G	Polyester: 0.047 µf ±2%, 100 VDCW; sim to
	9C300075P10002G	GE Type 61F. Polyester: 0.10 $\mu$ f $\pm 2\%$ , 100 VDCW; sim to
	9C300075 <b>P4</b> 7001G	GE Type 61F.  Polyester: 0.047 µf ±2%, 100 VDCW; sim to
C20A 1	9A700234P7	GE Type 61F. Polyester: 0.01 µf ±10%, 50 VDCW.
1	9A143477P22	Polyester: 0.047 µf ±5%, 50 VDCW.
1	496267P14	Tantalum: 15 $\mu f$ $\pm 20\%$ , 20 VDCW; sim to Sprague Type 150D.
C23 1	9A143477P22	Polyester: 0.047 $\mu$ f $\pm$ 5%, 50 VDCW.
C24 1	9A700234P9	Polyester: 0.022 µf ±10%, 50 VDCW.
C25 1	9A143477P19	Polyester: 0.033 µf ±20%, 50 VDCW.
C26 1	9A143477P26	Polyester: 0.1 µf ±20%, 50 VDCW.
C27 1	9A143477P27	Polyester: 0.1 μf ±10%, 50 VDCW.
C28 5	496267P18	Tantalum: 6.8 $\mu$ f $\pm 20\%$ , 35 VDCW; sim to Sprague Type 150D.
	6496267P10	Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D.
	L9A700233P7	Ceramic disc: 1000 pf ±20%, 50 VDCW.
_	L9A143486P21	Tantalum: 6.8 µf ±20%, 35 VDCW.
C32	L9A701534P4	Tantalum: 1 µf ±20%, 35 VDCW.
GP.1	1037822 <b>D</b> 2	Silicon, 1000 mA, 600 PIV.
CR1 thru CR4	1037822P2	
CR5 thru CR7	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
	4037822P2	Silicon, 1000 mA, 600 PIV.

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

SY	MBOL	GE PART NO.	DESCRIPTION	SYMBI
CRIC	0	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R3
CR1	1	4037822P2	Silicon, 1000 mA, 600 PIV.	and R4
CR12	2	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R5
CR15	1	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	and R6 R8
CR20	0	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	and R9
CR23	3	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R11 and R12
CR24	5*	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV. Added by REV C.	R13
CRZ	o+			R15A
El and		19A116683Pl	Protector, (Part of 19A129368G2 Kit).	R16
E2			PLUGS	R17A
			Connector. Includes:	R18*
P90	ı	101110000001		
		19A116659P21	Shell.  Contact, electrical: wire range No. 18-24 AWG;	
ļ		19A116781P5	sim to Molex 08-50-0106 (Quantity 2).	R19
		19A116781P6	Contact, electrical: wire range No. 22-26 AWG; sim to Molex 08-50-0108. (Quantity 8).	R20
		10000051001	Polarity tab. (Quantity 2).	R21A
P91	,	19B209519P1	Connector, Includes:	R22
Pai		19A116659P80	Shell.	R23
Ì		19A116781P6	Contact, electrical: wire range No. 22-26 ANG;	R24
		19411676176	sim to Molex 08-50-0108. (Quantity 4).	R25 and
Q1		19A115910P1	TRANSISTORS	R27
and Q2				R29
Q3		19A115852P1	Silicon, PNP; sim to Type 2N3906.	R3OA
Q4 and Q5		19A115910P1	Silicon, NPN; sim to Type 2N3904.	and R31A
Q6		19A115300P2	Silicon, NPN; sim to Type 2N3053.	R32A R33
Q7		19A115910P1	Silicon, NPN; sim to Type 2N3904.	R34
thr Q14				R35
Q15 and Q16	l	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R36
Q17 and Q18	l	19A129184P1	Silicon, NPN.	R37 R38
Q19		19A116774P1	Silicon, NPN; sim to Type 2N5210.	R39A
Q20		19A115300P4	Silicon, NPN.	R4 OA
Q21 and	l	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R41 R42
Q22 Q23		19A115852P1	Silicon, PNP; sim to Type 2N3906.	R43A
Q24		19A116774P1	Silicon, NPN; sim to Type 2N5210.	R44
Q25		19A115852P1	Silicon, PNP; sim to Type 2N3906.	R45
Q26		19A116774P1	Silicon, NPN; sim to Type 2N5210.	R46 and
Q27		19A115910P1	Silicon, NPN; sim to Type 2N3904.	R47
Q28		19A115852P1	Silicon, PNP; sim to Type 2N3906.	R48 and
Q29		19A115910P1	Silicon, NPN; sim to Type 2N3904.	R49
			DESIGNADS	R50
				R51
R1		19A700019P55	Deposited carbon: 33K ohms ±5%, 1/4 w. Deposited carbon: 47K ohms ±5%, 1/4 w.	R52 thru R54
R2		19A700019P57	Deposited Carbon, Air onmo 2003 Ar	1 1.53

DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART
omposition: 1.5K ohms ±5%, 2 w.	R55	19A700019 <b>P</b> 51	Deposited carbon: 15K ohms ±5%, 1/4 w.		
	R56	19A700019P33	Deposited carbon: 470 ohms ±5%, 1/4 w.	VR1	4036887P3
eposited carbon: 15K ohms ±5%, 1/4 w.	R57	19A143400P40	Deposited carbon: 2K ohms ±5%, 1/4 w.	VR2	4036887P5
	R58	19A700019P51	Deposited carbon: 15K ohms ±5%, 1/4 w.	VR3	4036887P11
omposition: 1.5K ohms ±5%, 1 w.	R59	19A143400P64	Deposited carbon: 200K ohms ±5%, 1/4 w.	VR4	19A116325P
	R60	19A700019P55	Deposited carbon: 33K ohms ±5%, 1/4 w.	VR5	4036887P8
eposited carbon: 8.2K ohms ±5%, 1/4 w.	and R61			VR6	4036887P11
eposited carbon: 10K ohms ±5%, 1/4 w.	R62	19A700019P57	Deposited carbon: 47K ohms ±5%, 1/4 w.	VR7	19A116325P
20V object 1/A w	R63	19A700019P55	Deposited carbon: 33K ohms ±5%, 1/4 w.		
eposited carbon: 82K ohms ±5%, 1/4 w.	R64	19A700019P14	Deposited carbon: 12 ohms ±5%, 1/4 w.		4036555P1
eposited carbon: 10K ohms ±5%, 1/4 w.	R65	19A143400P35	Deposited carbon: 750 ohms ±5%, 1/4 w.		19A116155P
ariable, carbon film: approx 200 to 5K ohms	R66	19A700019P67	Deposited carbon: 330K ohms ±5%, 1/4 w.		4029851P14
20%, 0.25 w; sim to CTS Type U-201.	R67	19A700019P59	Deposited carbon: 68K ohms ±5%, 1/4 w.		19C307038P
eposited carbon: 10K ohms $\pm 5\%$ , 1/4 w.	R68	19A700019P49	Deposited carbon: 10K ohms ±5%, 1/4 w.		19A121457P
eposited carbon: 3.3K ohms ±5%, 1/4 w.	R69	19A143400P40	Deposited carbon: 2K ohms ±5%, 1/4 w.  Deposited carbon: 100K ohms ±5%, 1/4 w.		19B219835P
arlier than REV A:	R70	19A700019P61 19A700019P61	Deposited carbon: 100K ohms ±5%, 1/4 w.  Deposited carbon: 100K ohms ±5%, 1/4 w.		19B201074P
omposition: 10K ohms ±5%, 1/4 w.	R72	19A700019P51	Deposited carbon: 15K ohms ±5%, 1/4 w.		
eposited carbon: 82K ohms ±5%, 1/4 w.	and R74	194700019F31	beposited Carbon. Iod on a 100, 17 - "		19B201074P
eposited carbon: 27K ohms ±5%, 1/4 w.	R74	19A700019P57	Deposited carbon: 47K ohms ±5%, 1/4 w.		19B201074F
eposited carbon: 10K ohms ±5%, 1/4 w.	R77	19A143400P52	Deposited carbon: 20K ohms ±5%, 1/4 w.		1074044570
posited carbon: 2.4K ohms ±5%, 1/4 w.	and R78				19D424457G
position: 620 ohms ±5%, 1/4 w.	R79 and R80	19A116310P5	Composition: 22 ohms ±5%, 1.0 w; sim to allen-Bradley Type GB.		1904244570
ited carbon: 30K ohms ±5%, 1/4 w.	R81	19A700019P21	Deposited carbon: 47 ohms ±5%, 1/4 w.		
ariable, carbon film: approx 300 to 10K ohms 20%, 0.25 w; sim to CTS Type U-201.	R82	19A700019P33	Deposited carbon: 470 ohms ±5%, 1/4 w.  Deposited carbon: 4.3K ohms ±5%, 1/4 w.		
eposited carbon: 33K ohms $\pm 5\%$ , $1/4$ w.	R84	19A143400P45	Deposited carbon: 5.1K ohms ±5%, 1/4 w.		
eposited carbon: 18K ohms $\pm 5\%$ , 1/4 w.	R85	19A700019P49	Deposited carbon: 10K ohms ±5%, 1/4 w.		
tal film: 16.9K ohms $\pm 1\%$ , 1/4 w.	R86	19A700019P57	Deposited carbon: 47K ohms ±5%, 1/4 w.		Ĭ
tal film: 9.09K ohms ±1%, 1/4 w.	R88 and R89	19A700019P25	Deposited carbon: 100 ohms ±5%, 1/4 w.		
tal film: 21.5K ohms $\pm 1\%$ , $1/4$ w.	R90	19A700019P36	Deposited carbon: 820 ohms ±5%, 1/4 w.		
al film: 14.7K ohms ±1%, 1/4 w.	R91*	19A143400P64	Deposited carbon: 200K ohms ±5%, 1/4 w. Added by		
al film: $1.47K$ ohms $\pm 1\%$ , $1/4$ w.			REV B.		1
al film: 3.48K ohms $\pm 1\%$ , $1/4$ w.					
al film: 1K ohms ±1%, 1/4 w.	T1	19A134368P1	Audio freq: 300 to 6000 Hz,	1	
al film; 2.15K ohms $\pm 1\%$ , $1/4$ w.			Pri: 27 ohms ±15%, Sec No. 1 & 2: 16.5 ohms ±15%.		
al film: 15.4K ohms $\pm 1\%$ , $1/4$ w.					
al film: 130K ohms ±1%, 1/4 w.	mai	19A116667P3	Nut, plate: sim to Malco X0-2879. (Quantity 5).		
osited carbon: 10K ohms $\pm 5\%$ , $1/4$ w. al film: 4.64K ohms $\pm 1\%$ , $1/4$ w.	TB1	19411606723	TEST POINTS		
al film: 255 ohms $\pm 1\%$ , $1/4$ w.	TP1	19B211379P1	Spring (Test Point).		
osited carbon: 10K ohms $\pm 5\%$ , $1/4$ w.	thru TP3				
sited carbon: 1K ohms ±5%, 1/4 w.			INTEGRATED CIRCUITS		
osáted carbon: 33K ohms ±5%, 1/4 w.	U1 and U2	19A134097P302	Digital (C MOS SERIES): QUAD 2- Input Nor Gate; sim to Vendor Type No. 4001.		
sited carbon: 240K ohms ±5%, 1/4 w.	U3 thru	19A116908P1	Optoelectronic coupler: Dual In Line 6 Pin Mini Dip Package; sim to TI TLL112.		
	U5				
osited carbon: 33K ohms ±5%, 1/4 w.	U5				
	U5				

GE PART NO.

19A700111P67

19A700019P51

19A700112P67

19A700019P48

19A700019P49

19A700019P60

19A700019P37 19A700019P49

19B209358P5

19A700019P49

19A700019P43

3R152P103J

19A700019P54

19A700019P49

19a143400P41

3R77P621J

19A143400P20

19A143400P54

19B209358P6

19A700019P55

19A700019P52

19C314256P21692

19C314256P29091

19C314256P22152

19C314256P21472

19C314256P21471

19C314256P23481

19C314256P21001

19C314256P22151

19C314256P21543 19C314256P21303

19A700019P49

19C314256P24641

19A701250P140

19A700019P49

19A700019P37

19A700019P55

19A143400P65

19A700019P55

19A143400P52

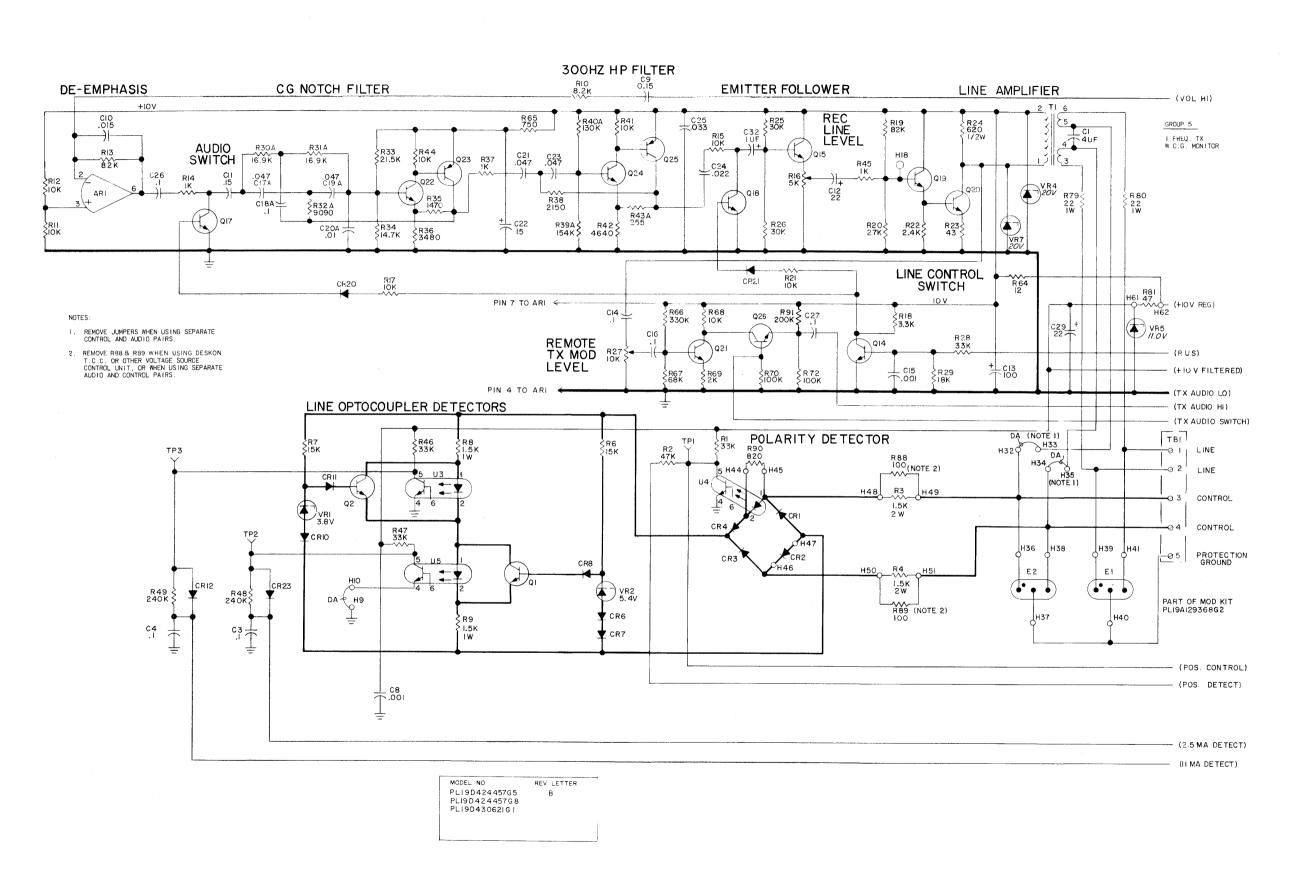
19A700019P55

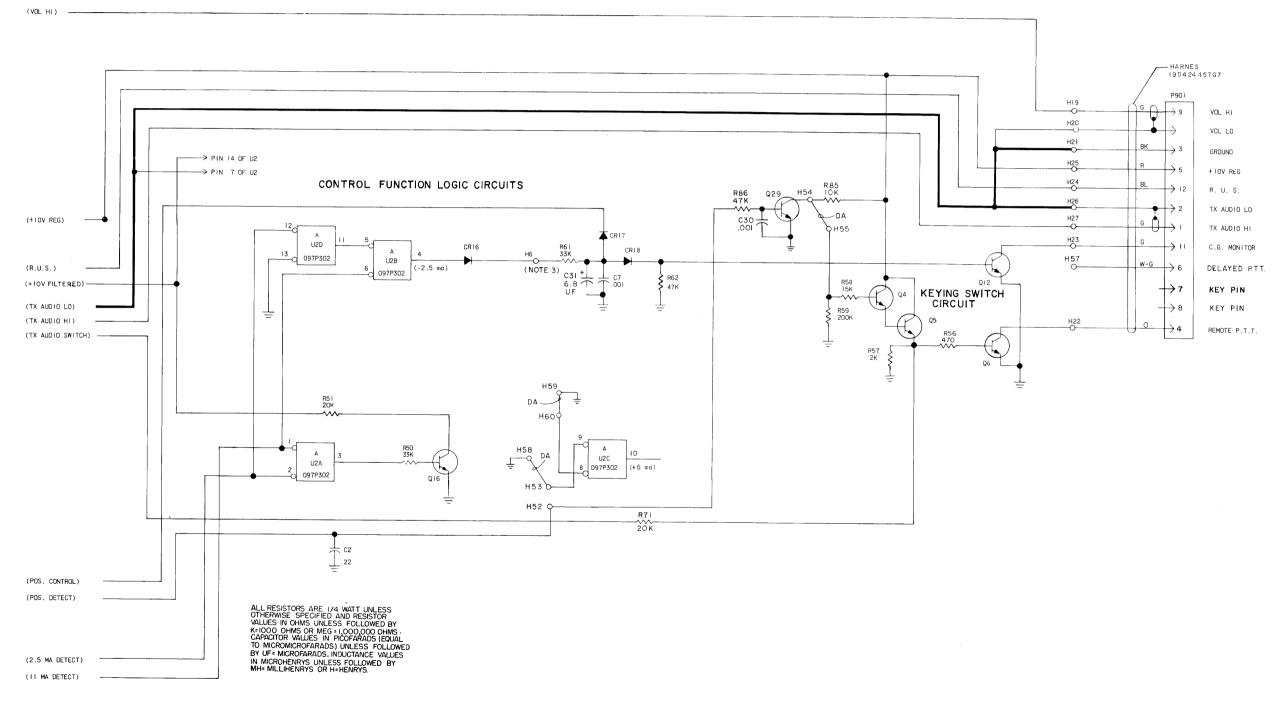
SYMBOL	GE PART NO.	DESCRIPTION
		VOLTAGE REGULATORS
VR1	4036887P3	Zener: 500 mW, 3.8 v. nominal.
VR2	4036887P5	Zener: 500 mw, 5.4 v. nominal.
VR3	4036887P11	Zener: 500 mW, 10.0 v. nominal.
VR4	19A116325P6	Zener; sim to Type 1N5357.
VR5	4036887P8	Zener: 500 mA, 11.0 v. nominal.
VR6	4036887P11	Zener: 500 mA, 10.0 v. nominal.
VR7	19A116325P6	Zener; sim to Type 1N5357.
		MISCELLANEOUS
	4036555P1	Insulator, washer: nylon. (Used with Q6, Q20)
	19A116155P1	Insulator. (Used with AR1).
	4029851P14	Clip loop. (Located by TB1-4).
	19C307038P11	Nut, push-on. (Secures clip loop at TB1-4).
	19A121457P1	Clamp. (Part of TBl strain relief).
	19B219835P1	Support. (Part of TBl strain relief clamp and support).
	19B201074P208	Tap screw, Phillips POZIDRIV®: No. 4-40 x 1/2. (Secures TB1 strain relief clamp and support).
	19B201074P304	Tap screw, Phillips POZIDRIV®: Io. 6-32 x 1/4. (Secures TB1-1 thru 4).
	19B201074P305	Tap screw, Phillips POZIDRIV®: No. 6-32 x 5/16 (Secures TB1-5).
	19D424457G6	Cable assembly. (Includes P911).
	19D424457G7	Cable assembly. (Includes P901).
1		
1		

### **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

- REV. A To improve audio squelching action on input to line amplifier.
  Changed value of R18.
- REV. B To reduce distortion of Mic pre-amp. Added R91.
- REV. C To prevent two oscillators being selected at the same time during transmit condition (G4 only). Added CR25 and CR26.





(19D424453, Sh. 2, Rev. 5)

SCHEMATIC DIAGRAM

DC REMOTE CONTROL BOARD 19D424457G5

Issue 4

1

PARTS LIST

DC REMOTE CONTROL BOARD 19D424457G5 ISSUE 1		
SYMBOL	GE PART NO.	DESCRIPTION
AR1	19A116297P2	Integrated circuit, linear: With TO99 Package, Operational Amplifier.
c1	7 <b>4</b> 864 <b>4</b> 5₽5	
C2	19A116080P9	Polyester: 0.22 µf ±20%, 50 VDCW.
C3A and C4	19A116080P7	Polyester: 0.1 μf ±20%, 50 VDCW.
C7 and C8	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
C9	19A116080P108	Polyester: 0.15 $\mu$ f ±10%, 50 VDCW.
C10	19A116080P102	Polyester: 0.015 $\mu$ f $\pm$ 10%, 50 VDCW.
C11	19A116080P8	Polyester: 0.15 $\mu$ f $\pm 20\%$ , 50 VDCW.
C12	5 <b>4</b> 96267P10	Tantalum: 22 $\mu$ f $\pm$ 20%, 15 VDCW; sim to Sprague Type 150D.
C13	19A115680P7	Electrolytic: 100 $\mu f$ +150% -10%, 15 VDCW; sim to Mallory Type TTX.
C14	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C15	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C16	19A116080P107	Polyester: 0.1 μf ±10%, 50 VDCW.
C17A	19C300075P47001G	Polyester: 7000 pf $\pm 2\%$ , 100 VDCW; sim to GE Type 61F.
C18A	19C300075P10002G	Polyester: 0.1 $\mu f$ $\pm 2\%$ , 100 VDCW; sim to GE Type 61F.
C19A	19C300075P47001G	Polyester: 7000 pf $\pm 2\%$ , 100 VDCW; sim to GE Type 61F.
C20A	19A116080P101	Polyester: 0.01 $\mu$ f $\pm 10\%$ , 50 VDCW.
C21	19A116080P205	Polyester: 0.047 µf ±5%, 50 VDCW.
C22	5496267P14	Tantalum: 15 $\mu f$ $\pm 20\%$ , 20 VDCW; sim to Sprague Type 150D.
C23	19A116080P205	Polyester: 0.047 µf ±5%, 50 VDCW.
C24	19A116080P103	Polyester: 0.022 μf ±10%, 50 VDCW.
C25	19A116080P4	Polyester: 0.033 μf ±20%, 50 VDCW.
C26	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C27	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C29 C30	5496267Pl0 5494481Pl11	Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.  Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to
	3111011111	RMC Type JF Discap.
C31	19A134202P15	Tantalum: 6.8 µf ±20%, 35 VDCW.
C32	19A134202P14	Tantalum: 1 μf ±20%, 35 VDCW.
		DIODES AND RECTIFIERS
CR1 thru CR4	4037822P2	Silicon, 1000 mA, 600 PIV.
CR6 and CR7	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
CR8	4037822P2	Silicon, 1000 mA, 600 PIV.
CR10	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
CR11	4037822P2	Silicon, 1000 mA, 600 PIV.

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
CR12	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R16	19B209358P5	Variable, carbon film: approx 200 to ±20%, 0.25 w; sim to CTS Type U-201.
CR16	19A115250Pl	Silicon, fast recovery, 225 mA, 50 PIV.	R17A	19A700019P49	Deposited carbon: 10K ohms ±5%, 0.25
thru CR18			R18*	19A700019P43	Deposited carbon: 3.3K ohms ±5%, 0.2
CR20	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.			Earlier than REV A:
and CR21				3R152P103J	Composition: 10K ohms ±5%, 1/4 w.
CR23	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R19	19A700019P60	Deposited carbon: 82K ohms ±5%, 0.25
			R20	19A700019P54	Deposited carbon: 27K ohms ±5%, 0.25
E1	19Al16683Pl	Protector. (Part of 19A129368G2 Kit).	R21A	19A700019P49	Deposited carbon: 10K ohms ±5%, 0.25
and E2	15/11/006571	Protector. (Part of ISA12550002 Rity).	R22	19A143400P41	2.4K ohms ±5%, 1/4 w.
			R23	19A143400P20	Deposited carbon: 43 ohms ±5%, 1/4 w
P901		Connector. Includes:	R24	3R77P621J	Composition: 620 ohms ±5%, 1/2 w.
	19A116659P21	Shell.	R25 and	19A143400P54	Deposited carbon: 30K ohms ±5%, 1/4
	19A116781P5	Contact, electrical: wire range No. 18-24 AWG;	R26		
	10.1110	sim to Molex 08-50-0106. (Quantity 2).	R27	19B209358P6	Variable, carbon film: approx 300 to ±20%, 0.25 w; sim to CTS Type U-201.
	19A116781P6	Contact, electrical: wire range No. 22-26 AWG; sim to Molex 08-50-0108. (Quantity 8).	R28	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25
	19B209519P1	Polarity Tab. (Quantity 2).	R29	19A700019P52	Deposited carbon: 18K ohms ±5%, 0.25
			R3OA	19C314256P21692	Metal film: 16.9K ohms ±1%, 1/4 w.
			R31A	19C314256P21692	Metal film: 16.9K ohms ±1%, 1/4 w.
l ind	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R32A	19C314255P29091	Metal film: 9.09K ohms ±1%, 1/4 w.
12			R33	19C314256P22152	Metal film: 21.5K ohms ±1%, 1/4 w.
Q4 and	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R34	19C314256P21472	Metal film: 14.7K ohms ±1%, 1/4 w.
:5			R35	19C314256P21471	Metal film: 1.47K ohms ±1%, 1/4 w.
96	19A115300P2	Silicon, NPN; sim to Type 2N3053.	R36	19C314256P23481	Metal film: 3.48K ohms ±1%, 1/4 w.
Q12	19A115910P1	Silicon, NPN; sim to Type 2N3904.	R37	19C314256P21001	Metal film: 1K ohms ±1%, 1/4 w.
14	19A115910P1	Silicon, NPN; sim to Type 2N3904.			
Q15 and	19All6774Pl	Silicon, NPN; sim to Type 2N5210.	R38	19C314256P22151	Metal film: 2.15K ohms ±1%, 1/4 w.
Q16			R39A	19C314256P21543	Metal film: 154K ohms ±1%, 1/4 w.
17 .nd	19A129184P1	Silicon, NPN.	R4OA	19C314256P21303	Metal film: 130K ohms $\pm 1\%$ , 1/4 w.
18	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R41	19A700019P49	Deposited carbon: 10K ohms ±5%, 0.25
219 220	19A115774P1 19A115300P4	Silicon, NPN.	R42	19C314256P24641	Metal film: 4.6K ohms $\pm 1\%$ , $1/4$ w.
<sub>120</sub> 121	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R43A	19C314256P22550	Metal film: 255 ohms $\pm 1\%$ , $1/4$ w.
and	19A110774P1	Silicon, NPN, Sim to Type 2N0210.	R44	19A700019P49	Deposited carbon: 10K ohms ±5%, 0.25
222	19A115852P1	Silicon, PNP; sim to Type 2N3906.	R45	19A700019P37	Deposited carbon: 1K ohms ±5%, 0.25
223	Į.	Silicon, NPN; sim to Type 2N5210.	R46	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25
24	19A116774P1	Silicon, PNP; sim to Type 2N3910.	and R47		
25	19A115852P1 19A116774P1	Silicon, NPN; sim to Type 2N5210.	R48	19A143400P65	Deposited carbon: 240K ohms ±5%, 1/4
26 29	19A115774P1 19A115910P1	Silicon, NPN; sim to Type 2N3904.	and R49		
25	19411391001	billeon, RPR, Sim to Type 2.00021.	R50	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25
			R51	19A143400P52	Deposited carbon: 20K ohms $\pm 5\%$ , $1/4$
31	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25 w.	R56	19A700019P33	Deposited carbon: 470 ohns $\pm 5\%$ , 0.25
12	19A700019P57	Deposited carbon: 47K ohms ±5%, 0.25 w.	R57	19A143400P40	Deposited carbon: 2K ohms ±5%, 1/4 w
R3 and	3R79P152K	Composition: 1.5K ohms ±10%, 2 w.	R58	19A700019P51	Deposited carbon: 16K ohms ±5%, 0.25
24			R59	19A143400P64	Deposited carbon: 200K ohms ±5%, 1/4
R6 and	19A700019P51	Deposited carbon: 15K ohms $\pm 5\%$ , 0.25 w.	R61	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25
27			R62	19A700019P57	Deposited carbon: 47K ohms ±5%, 0.25
R8 and	19A700112P67	Composition: 1.5K ohms ±5%, 1 w.	R64	19A700019P14	Deposited caroon: 12 ohms ±5%, 0.25
R9			R65	19A143400P35	Deposited carbon: 750 ohms ±5%, 1/4
R10	19A700019P48	Deposited carbon: 8.2K ohms ±5%, 0.25 w.	R66	19A700019P67	Deposited carbon: 0.33M ohms ±5%, 0.
R11 and	19A700019P49	Deposited carbon: 10K ohms $\pm 5\%$ , 0.25 w.	R67	19A700019P59	Deposited carbon: 68K ohms ±5%, 0.25
112			R68	19A700019P49	Deposited carbon: 10K ohms ±5%, 0.25
113	19A700019P60	Deposited carbon: 82K ohms ±5%, 0.25 w.	R69	19A143400P40	Deposited carbon: 2K ohms ±5%, 1/4 w
			l I	104500010001	I D
114	19A700019P37	Deposited carbon: 1K ohms ±5%, 0.25 w.  Deposited carbon: 10K ohms ±5%, 0.25 w.	R70	19A700019P61	Deposited carbon: 0.1M ohms ±5%, 0.2

SYMBOL	GE PART NO.	DESCRIPTION
R71	19A143400P52	Deposited carbon: 20K ohms ±5%, 1/4 w.
R72	19A700019P61	Deposited carbon: 0.1M ohms ±5%, 0.25 w.
R79	19A116310P5	Composition: 22 ohms ±5%, 1.0 w; sim to Allen-
and R80		Bradley Type G3.
R81	19A700019P21	Composition: 47 ohms ±5%, 1/4 w.
R85	19A700019P49	Composition: 10K ohms ±5%, 1/4 w.
R86	19A700019P57	Composition: 47K ohms ±5%, 1/4 w.
R88 and R89	19A700019P25	Composition: 100 ohms ±5%, 1/4 w.
R90	19A700019P36	Composition: 820 ohms ±5%, 1/4 w.
R91*	19A143400P64	Deposited carbon: 200K ohms ±5%, 1/4 w. Added by REV B.
T1	19A134368P1	Audio freq: 300 to 6000 Hz, Pri: 27 ohms ±15%, Sec No. 1 & 2: 16.5 ohms ±15%.
TB1	19A116667P3	Nut, plate: sim to Malco X0-2879. (Quantity 5).
		TEST POINTS
TP1 thru TP3	19B211379P1	Spring (Test Point).
113		
U2	19A134097P332	Digital, QUAD 2- Input Nor Gate: Identification No. 4001.
U3 thru U5	19A116908P1	Optoelectronic coupler: Dual In Line 6 Pin Mini Dip Package; sim to TI T1L112.
VR1 VR2 VR4 VR5 VR7	4036887P3 4036887P5 19A116323P6 4036887P8 19A116325P6	Zener: 500 mW, 3.8 v. nominal.  Zener: 500 mW, 5.4 v. nominal.  Zener: sim to Type 1N5357.  Zener: 500 mW, 11.0 v. nominal.  Zener: sim to Type 1N5357.  HARNESS ASSEMBLY 19042445767
		(Includes P901)
		MISCELLANEOUS
	4036555P1	Insulator, washer: nylon. (Used with Q6, Q20).
	19A116155P1	Insulator. (Used with ARI).
	4029851P14 19C307038P11	Clip loop. (Located by TB1-4).
	19C307038PII 19A121457PI	Nut, push-on. (Secures clip loop at TB1-4).  Clamp. (Part of TB1 strain relief).
	19A121457P1 19B219835P1	Support. (Part of TB1 strain relief clamp and
	19B201074P208	support).  Tap screw, Phillips POZIDRIV®: No. 4-40 x 1/2. (Secures TBl strain relief clamp and support).
	19B201074P304	Tap screw, Phillips POZIDRIV®: No. 6-32 x 1/4.
	1000030515555	(Secures TB1-1 thru 4).
	19B201074P305	Tap screw, Phillips POZIDRIV®: No. 6-32 x 5/16. (Secures TB1-5).

Variable, carbon film: approx 200 to 5K ohms  $\pm 20\%$ , 0.25 w; sim to CIS Type U-201.

Deposited carbon: 10K ohms ±5%, 0.25 w. Deposited carbon: 3.3K ohms ±5%, 0.25 w.

Composition: 10K ohms ±5%, 1/4 w. Deposited carbon: 82K ohms  $\pm 5\%$ , 0.25 w. Deposited carbon: 27K ohms ±5%, 0.25 w. Deposited carbon: 10K ohms ±5%, 0.25 w.

Deposited carbon: 43 ohms ±5%, 1/4 w. Composition: 620 ohms ±5%, 1/2 w. Deposited carbon: 30K ohms ±5%, 1/4 w.

Metal film: 154K ohms  $\pm 1\%$ , 1/4 w. Metal film: 130K ohms  $\pm 1\%$ , 1/4 w. Deposited carbon: 10K ohms ±5%, 0.25 w.

Deposited carbon: 10K ohms ±5%, 0.25 w. Deposited carbon: 1K ohms ±5%, 0.25 w. Deposited carbon: 33K ohms ±5%, 0.25 w.

Deposited carbon: 24  ${
m MK}$  ohms  ${
m \pm}5\%$  , 1/4 w.

Deposited carbon: 33K ohms ±5%, 0.25 w. Deposited carbon: 20K ohms  $\pm 5\%$ , 1/4 w. Deposited carbon: 470 ohms ±5%, 0.25 w. Deposited carbon: 2K ohms ±5%, 1/4 w. Deposited carbon: 16K ohms ±5%, 0.25 w. Deposited carbon: 200 K ohms  $\pm 5\%$ , 1/4 w. Deposited carbon: 33K ohms ±5%, 0.25 w. Deposited carbon: 47K ohms ±5%, 0.25 w. Deposited carbon: 12 ohms ±5%, 0.25 w. Deposited carbon: 750 ohms ±5%, 1/4 w. Deposited carbon: 0.33M ohms  $\pm 5\%$ , 0.25 w. Deposited carbon: 68K ohms ±5%, 0.25 w. Deposited carbon: 10K ohms ±5%, 0.25 w. Deposited carbon: 2K ohms ±5%, 1/4 w. Deposited carbon: 0.1M ohms  $\pm 5\%$ , 0.25 w.

Variable, carbon film: approx 300 to 10K ohms  $\pm 20\%$ , 0.25 w; sim to CTS Type U-201. Deposited carbon: 33K ohms ±5%, 0.25 w. Deposited carbon: 18K ohms ±5%, 0.25 w. Metal film: 16.9K ohms  $\pm 1\%$ , 1/4 w. Metal film: 16.9K ohms  $\pm 1\%$ , 1/4 w. Metal film: 9.09K ohms  $\pm 1\%$ , 1/4 w. Metal film: 21.5K ohms  $\pm 1\%$ , 1/4 w.

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

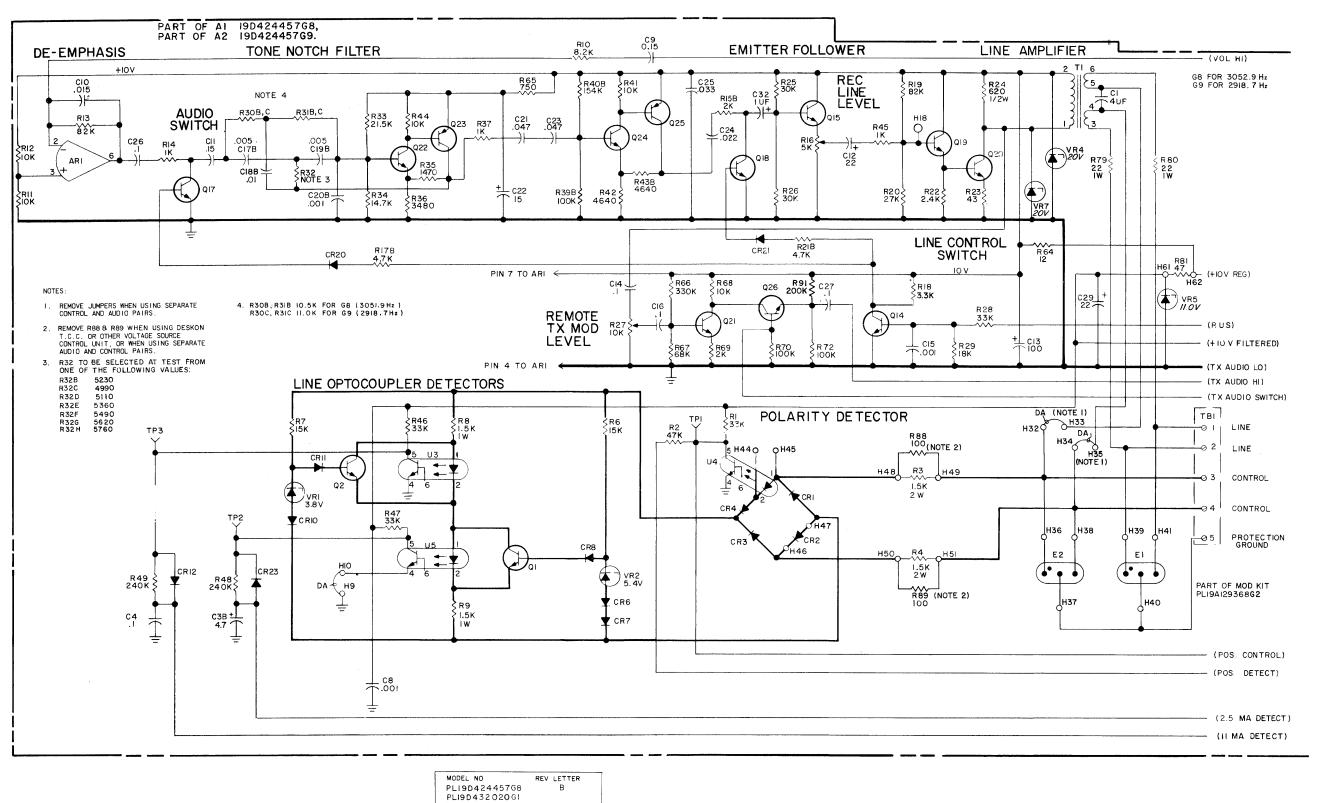
### **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

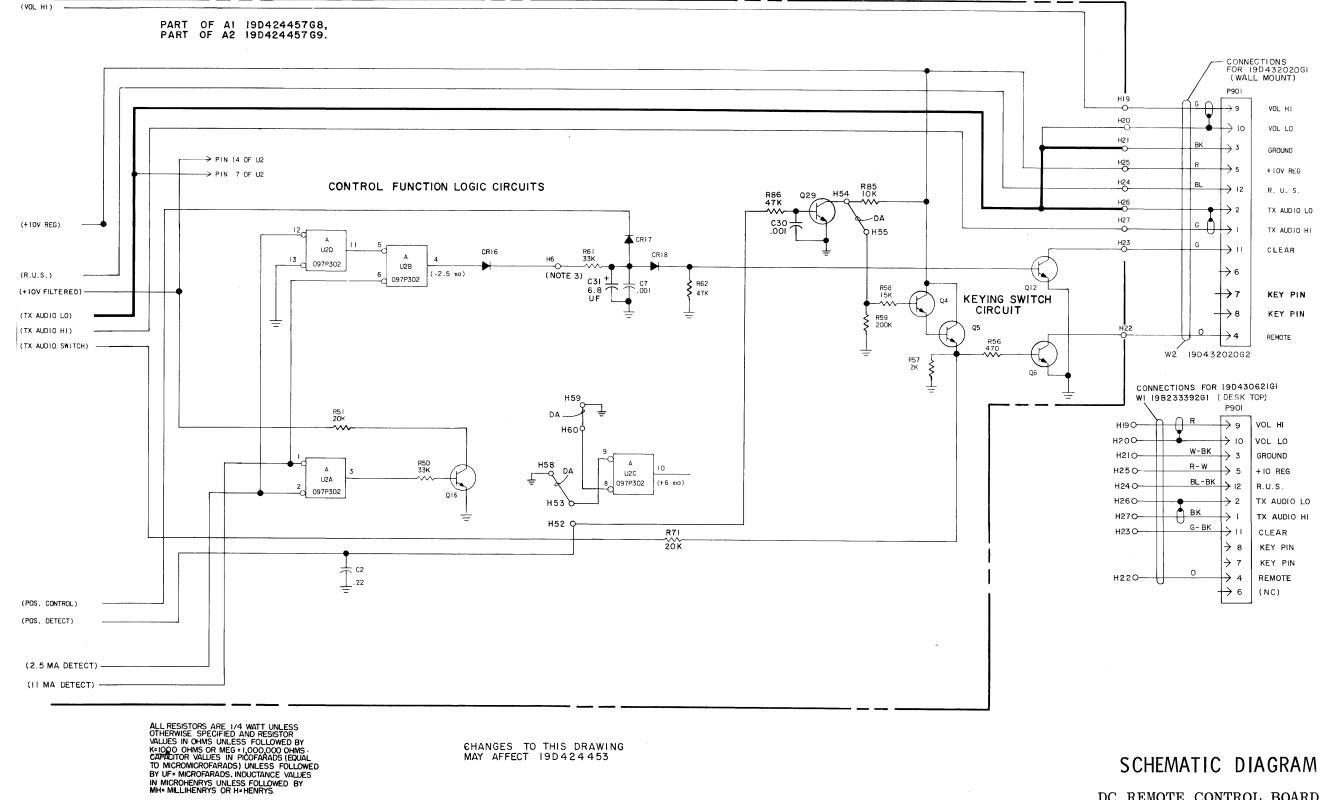
#### REV. A - 19D424457G5

To improve audio squelching action on input to line amplifier. Changed value of R18.

REV. B - To reduce distortion of Mic pre-amp. Added R91.



PLI9D43062IGI PLI9D424457G9 PLI9D43062IG2



CHANGES TO THIS DRAWING MAY AFFECT 19D424453

SCHEMATIC DIAGRAM

DC REMOTE CONTROL BOARD 19D424457G8 & G9

(19D432046, Sh. 2, Rev. 1)

Issue 4

#### PARTS LIST

LB130571E

DC REMOTE CONTROL BOARD 19D424457G8 3051.9 Hz BUSY TONE

SYMBOL	GE PART NO.	DESCRIPTION
AR1	19A116297P2	Integrated circuit, linear: With TO99 Package, Operational Amplifier.
C1	7486445P5	Electrolytic, non polarized: 4 μf +100% -10%, 150 VDCW.
C2	19A116080P9	Polyester: 0.22 µf ±20%, 50 VDCW.
СЗВ	19A134202P3	Tantalum: 4.7 μf ±20%, 10 VDCW.
C4	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C7 and C8	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
C9	19A116080P108	Polyester: 0.15 µf ±10%, 50 VDCW.
C10	19A116080P102	Polyester: 0.015 µf ±10%, 50 VDCW.
C11	19A116080P8	Polyester: 0.15 µf ±20%, 50 VDCW.
C12	5496267P10	Tantalum: 22 $\mu$ f $\pm 20\%$ , 15 VDCW; sim to Sprague Type 150D.
C13	19A115680P7	Electrolytic: 100 µf +150% -10%, 15 VDCW; sim to Mallory Type TTX.
C14	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C15	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C16	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C17B	19C307114P5001G	Polystyrene: 5000 pf ±2%, 100 VDCW, temp coef -120±30 PPM/°C.
C18B	19C307114P1002G	Polystyrene: 0.01 µf ±2%, 100 VDCW, temp coef -120±30 PPM/°C.
C19B	19C307114P5001G	Polystyrene: 5000 pf ±2%, 100 VDCW, temp coef -120±30 PPM/°C.
C20B	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C21	19A116080P205	Polyester: 0.047 µf ±5%, 50 VDCW.
C22	5496267P14	Tantalum: 15 $\mu$ f $\pm 20\%$ , 20 VDCW; sim to Sprague Type 150D.
C23	19A116080P205	Polyester: 0.047 µf ±5%, 50 VDCW.
224	19A116080P103	Polyester: 0.022 µf ±10%, 50 VDCW.
C25	19A116080P4	Polyester: 0.033 µf ±20%, 50 VDCW.
C26	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C27	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C29	5496267P10	Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D.
C30	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
231	19A134202P15	Tantalum: 6.8 μf ±20%, 35 VDCW.
C32	19A134202P14	Tantalum: 1 μf ±20%, 35 VDCW.
		DIODES AND RECTIFIERS
CR1 thru CR4	4037822P2	Silicon, 1000 mA, 600 PIV.
CR6 and	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
CR7 CR8	4037822P2	Silicon, 1000 mA, 600 PIV.
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\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

SYMBOL	GE PART NO.	DESCRIPTION
CR11	4037822P2	Silicon, 1000 mA, 600 PIV.
CR12	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
CR16 thru CR18	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
CR20 and CR21	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
CR23	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
E1 and E2	19A116683P1	Protector. (Part of 19A129368G2 Kit).
P911		Connector. Includes:
	19A116659P80	Shell.
	19A116781P6	Contact, electrical: wire range No. 22-26 AWG; sim to Molex 08-50-0108. (Quantity 8).
Q1 and Q2	19A115910P1	Silicon, NPN; sim to Type 2N3904.
Q4 and Q5	19A115910P1	Silicon, NPN; sim to Type 2N3904.
Q6	19A115300P2	Silicon, NPN; sim to Type 2N3053.
Q12	19A115910P1	Silicon, NPN; sim to Type 2N3904.
Q14	19A115910P1	Silicon, NPN; sim to Type 2N3904.
Q15 and Q16	19A116774P1	Silicon, NPN; sim to Type 2N5210.
Q17 and	19A129184P1	Silicon, NPN.
Q18 Q19	19A116774P1	Silicon, NPN; sim to Type 2N5210.
Q20	19A115300P4	Silicon, NPN.
Q21 and Q22	19Al16774Pl	Silicon, NPN; sim to Type 2N5210.
Q23	19A115852P1	Silicon, PNP; sim to Type 2N3906.
224	19A116774P1	Silicon, NPN; sim to Type 2N5210.
Q25	19A115852P1	Silicon, PNP; sim to Type 2N3906.
Q26	19A116774P1	Silicon, NPN; sim to Type 2N5210.
Q29	19A115910P1	Silicon, NPN; sim to Type 2N3904.
		RESISTORS
R1	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25 w.
R2	19A700019P57	Deposited carbon: 47K ohms ±5%, 0.25 w.
R3 and R4	3R79P152K	Composition: 1.5K ohms $\pm 10\%$ , 2 w.
R6 and R7	19A700019P51	Deposited carbon: 15K ohms ±5%, 0.25 w.
R8 and R9	19A700112P67	Composition: 1.5K ohms ±5%, 1 w.
R10	19A700019P48	Deposited carbon: 8.2K ohms ±5%, 0.25 w.
R11 and R12	19A700019P49	Deposited carbon: 10K ohms ±5%, 0.25 w.
R13	19A700019P60	Deposited carbon: 82K ohms ±5%, 0.25 w.
R14	19A700019P37	Deposited carbon: 1K ohms ±5%, 0.25 w.
R15B	19A143400P40	Deposited carbon: 2K ohms ±5%, 1/4 w.
R16	19B209358P5	Variable, carbon film: approx 200 to 5K ohms ±20%, 0.25 w; sim to CTS Type U-201.

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SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
	10.1000010010		R67	19A700019P59	Deposited carbon: 68K ohms ±5%, 0.25 w.
R17B	19A700019P45	Deposited carbon: 4.7K ohms ±5%, 0.25 w.	R68	19A700019P49	Deposited carbon: 10K ohms ±5%, 0.25 w.
R18*	19A700019P43	Deposited carbon: 3.3K ohms ±5%, 0.25 w.	R69	19A143400P40	Deposited carbon: 2K ohms ±5%, 1/4 w.
	2015001027	Earlier than REV A:	R70	19A700019P61	Deposited carbon: 0.1M ohms ±5%, 0.25 w.
D10	3R152P103J	Composition: 10K ohms ±5%, 1/4 w.	R71	19A143400P52	Deposited carbon: 20K ohms ±5%, 1/4 w.
R19	19A700019P60	Deposited carbon: 82K ohms ±5%, 0.25 w.	R72	19A700019P61	Deposited carbon: 0.1M ohms ±5%, 0.25 w.
R20	19A700019P54	Deposited carbon: 27K ohms ±5%, 0.25 w.	R79	19A116310P5	Composition: 22 ohms ±5%, 1.0 w; sim to Allen-
R21B	19A700019P45	Deposited carbon: 4.7K ohms ±5%, 0.25 w.	and R80		Bradley Type GB.
R22 R23	19A143400P41 19A143400P20	Deposited carbon: 2.4K ohms ±5%, 1/4 w.	R81	19A700019P21	Composition: 47 ohms ±5%, 1/4 w.
R24	3R77P621J	Deposited carbon: 43 ohms ±5%, 1/4 w.  Composition: 620 ohms ±5%, 1/2 w.	R85	19A700019P49	Composition: 10K ohms ±5%, 1/4 w.
R24 R25	19A143400P54	Deposited carbon: 30K ohms ±5%, 1/4 w.	R86	19A700019P57	Composition: 47K ohms ±5%, 1/4 w.
and R26	194143400254	beposited carbon. Sok onms 15%, 1/4 w.	R88	19A700019P25	Composition: 100 ohms ±5%, 1/4 w.
R27	19B209358P6	Variable, carbon film: approx 300 to 10K ohms ±20%, 0.25 w; sim to CTS Type U-201,	and R89 R91*	104142400064	Deposited carbon: 200K ohms ±5%, 1/4 w. Added
R28	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25 w.	K91*	19A143400P64	by REV B.
R29	19A700019P52	Deposited carbon: 18K ohms ±5%, 0.25 w.			
R30B	19C314258P21052	Metal film: 10.5K ohms ±1%, 1/4 w.	T1	19A134368P1	Audio freq: 300 to 6000 Hz,
R30C	19C314256P21102	Metal film: 11K ohms $\pm 1\%$ , 1/4 w.		198134300P1	Pri: 27 ohms ±15%, Sec No. 1 & 2: 16.5 ohms ±15%.
R31B	19C314256P21052	Metal film: 10.5K ohms ±1%, 1/4 w.			Sec NO. 1 & 2. 16.5 OHMS 115%.
R31C	19C314256P21102	Metal film: llK ohms ±1%, 1/4 w.	: [		TERMINAL BOARDS
R32B	19C314256P25231	Metal film: 5.2K ohms $\pm 1\%$ , $1/4$ w.	TB1	19A116657P3	Nut, plate: sim to Malco X0-2879. (Quantity 5).
R32C	19C314256P24991	Metal film: 4.9K ohms $\pm 1\%$ , $1/4$ w.			TEST POINTS
R32D	19C314256P25111	Metal film: 5.1K ohms $\pm 1\%$ , $1/4$ w.	TP1	19B211379P1	Spring (Test Point).
R32E	19C314256P25361	Metal film: 5.3K ohms ±1%, 1/4 w.	thru TP3	19821137971	bpling (lost rolnty).
R32F	19C314256P24491	Metal film: 4.4K ohms $\pm 1\%$ , $1/4$ w.	1173		
R32G	19C314256P25622	Metal film: 56.2K ohms ±1%, 1/4 w.		1041040077700	INTEGRATED CIRCUITS
R32H	19C314256P25762	Metal film: 57.6K ohms $\pm 1\%$ , $1/4$ w.	U2	19A134097P302	Digital, QUAD 2- Input Nor Gate: Identification No. 4001.
R33	19C314256P22152	Metal film: 21.5K ohms ±1%, 1/4 w.	U3	19A116908P1	Optoelectronic coupler: Dual In Line 6 Pin Mini
R34	19C314256P21472	Metal film: 14.7K ohms $\pm 1\%$ , 1/4 w.	thru U5		Dip Package; sim to TI TlL112.
R35	19C314256P21471	Metal film: 1.47K ohms ±1%, 1/4 w.			
R36	19C314256P23481	Metal film: 3.48K ohms $\pm 1\%$ , $1/4$ w.	VR1	4036887P3	Zener: 500 mW, 3.8 v. nominal.
R37	19C314256P21001	Metal film: 1K ohms ±1%, 1/4 w.	VR2	4036887P5	Zener: 500 mW, 5.4 v. nominal.
R39B	19C314256P21003	Metal film: 100K ohms ±1%, 1/4 w.	VR4	19A116325P6	Zener: sim to Type 1N5357.
R4 0B	19C314256P21543	Metal film: 154K ohms ±1%, 1/4 w.	VR5	4036887P8	Zener: 500 mW, 11.0 v. nominal.
R41	19A700019P49	Deposited carbon: 10K ohms ±5%, 0.25 w.	VR7	19A116325P6	Zener: sim to Type 1N5357.
R42	19C314253P24641	Metal film: 4.6K ohms ±1%, 1/4 w.			MISCELLANEOUS
R43B	19C314256P24641	Metal film: 4.6K ohms ±1%, 1/4 w.  Deposited carbon: 10K ohms ±5%, 0.25 w.		4036555Pl	Insulator, washer: nylon. (Used with Q6, Q20).
R44	19A700019P49 19A700019P37	Deposited carbon: 10k ohms ±5%, 0.25 w.  Deposited carbon: 1k ohms ±5%, 0.25 w.		19A116155P1	Insulator. (Used with AR1).
R45	1	Deposited carbon: 33K ohms ±5%, 0.25 w.		4029851P14	Clip loop. (Located by TB1-4).
R46 and	19A700019P55	Doposition outson. Out ones to by Villo W.		19C307038P11	Nut, push-on. (Secures clip loop at TB1-4).
R47	19A143400P65	Deposited carbon: 240K ohms ±5%, 1/4 w.		19A121457P1	Clamp. (Part of TB1 strain relief).
and R49	154145400705			19B219835P1	Support. (Part of TB1 strain relief clamp and support).
R50	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25 w.		19B201074P208	Tap screw, Phillips POZIDRIV®: No. 4-40 x 1/2. (Secures TBl strain relief clamp and support).
R51	19A143400P52	Deposited carbon: 20K ohms ±5%, 1/4 w.		1000010740204	(Secures TBI strain relief clamp and support).  Tap screw, Phillips POZIDRIV®: No. 6-32 x 1/4.
R56	19A700019P33	Deposited carbon: 470 ohms ±5%, 0.25 w.		19B201074P304	(Secures TB1-1 thru 4).
R57	19A143400P40	Deposited carbon: 2K ohms ±5%, 1/4 w.		19B201074P305	Tap screw, Phillips POZIDRIV®: No. 6-32 x 5/16. (Secures TB1-5).
R58	19A700019P51	Deposited carbon: 16K ohms ±5%, 0.25 w.			(Seedles IDI-0).
R59	19A143400P64	Deposited carbon: 200K ohms ±5%, 1/4 w.			
R61	19A700019P55	Deposited carbon: 33K ohms ±5%, 0.25 w.			
R62	19A700019P57	Deposited carbon: 47K ohms ±5%, 0.25 w.			
R64	19A700019P14	Deposited carbon: 12 ohms ±5%, 0.25 w.			
R65	19A143400P35	Deposited carbon: 750 ohms ±5%, 1/4 w.			
R66	19A700019P67	Deposited carbon: 0.33M ohms ±5%, 0.25 w.			
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**PRODUCTION CHANGES** 

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - 19D424457G8

To prevent a false "CLEAR" after the release of PTT and to improve the audio muting. Deleted C3, R17 and R21. Added C3B, R17B and R21B.

REV. B - To prevent a false "CLEAR" at the beginning of each PTT. Deleted R90.

#### PARTS LIST

LBI-30572

TELEPHONE LINE SURGE PROTECTOR KIT 19A129368G2

GE PART NO.	DESCRIPTION
19A134356P1	Telephone Protector.
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•	
	GE PART NO. 19A134356P1

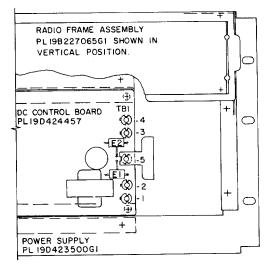
THESE INSTRUCTIONS COVER THE INSTALLATION OF TELEPHONE LINE SURGE PROTECTION KIT PL19A129368G2 TO MASTR EXEC II STATION.

#### INSTRUCTIONS:

- 1. SOLDER EI & E2 TO BOARD AS SHOWN.
- 2. TRIM LEADS ON EI 8 E2 TO .09 MAX. ON SOLDER SIDE OF PW BOARD.

#### NOTES

- I. THE EFFECTIVENESS OF THE LINE PROTECTORS IS DEPENDENT UPON A GOOD EARTH GROUND. THE GROUND CONNECTION SHOULD BE MADE WITH A SINGLE 14 AWG OR LARGER COPPER CONDUCTOR AND SHOULD BE CONNECTED TO THE GROUND SIDE OF THE PROTECTORS AT TBI-5. THE CONDUCTOR SHOULD BE SHORT, STRAIGHT AND A CONTINUOUS PIECE OF WIRE.
- 2. PROVIDE THE LOWEST POSSIBLE RESISTANCE AT THE CONNECTORS AT EACH END OF THE GROUND WIRE.



(19B227171, Sh. 2, Rev. 0)

SERVICE SHEET

TELEPHONE LINE SURGE PROTECTION OPTION 9905